



XTR30010

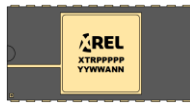
High Temperature PWM Controllers

Rev 9 - August 2021 (DS-00001-10)

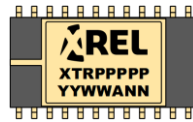
Data Sheet



PRODUCTION



DIP24
XTR30011
XTR30014



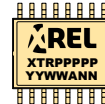
SOIC24
XTR30011
XTR30014



DIP8
XTR30015
XTR30016



CDFP10
XTR30017



SOIC16
XTR30018



FEATURES

- Supply voltage up to 50V.
- Operational beyond the -60°C to +230°C temperature range.
- Monolithic PWM controller.
- Internal linear regulator with under voltage lockout (ULVO).
- Input voltage feed-forward.
- Selectable asynchronous and pulse-skip modes.
- Selectable output signal polarity: active HIGH or LOW.
- Resistor programmable maximum duty cycle.
- Programmable integrated oscillator with synchronizing capability.
- Resistor-programmable soft-start period.
- Power-good (PGood) flag.
- Programmable over-current protection level.
- Programmable polarity of over-current protection.
- Programmable minimum duty-ratio in pulse-skip mode.
- Voltage tracking capabilities.
- Shut-down mode.
- Interleaved mode for push-pull architectures.
- Forced bootstrap capacitor pre-charge mode.
- Latch-up free.
- Ruggedized SMT and thru-hole packages.
- Also available as bare die.

DESCRIPTION

XTR30010 is a family of small footprint PWM controllers de-signed for extreme reliability and high temperature applications such as DC/DC converters and PWM control. Being able to operate from input voltages as high as 50V, XTR30010 PWM controllers can run at frequencies as high as 800kHz, allowing the use of small footprint and low-cost external passive components.

Functionality features include internal oscillator and voltage reference, programmable soft-start, voltage tracking, synchronization capability, over-current protection and power-good flag.

Special design techniques were used to allow the XTR30010 parts to offer a precise, robust and reliable operation in critical applications. Full functionality is guaranteed from -60°C to +230°C, though operation well below and above this temperature range is achieved.

Parts from the XTR30010 family have all functional features to operate in buck, boost, buck-boost, flyback and push-pull modes.

Standard packaging options range from full-featured 24-lead packages to small footprint 8-lead packages.

XTR30010 family parts have been designed to reduce system cost and ease adoption by reducing the learning curve and providing smart and easy to use features.

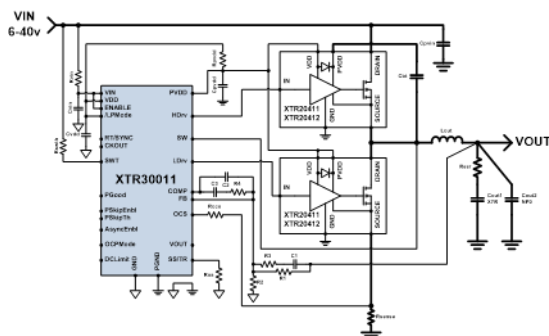
Parts from the XTR30010 family are available in ruggedized SMT and thru-hole packages. Parts are also available as bare dies.

APPLICATIONS

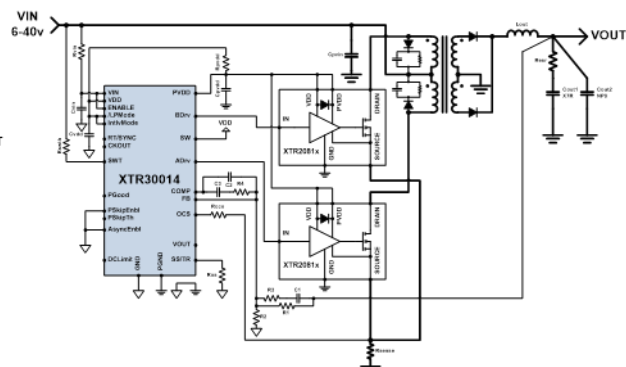
- Reliability-critical, Automotive, Aeronautics & Aerospace, Down-hole.
- DC/DC converters, point-of-load power converters, switching power supplies, PWM control.

PRODUCT HIGHLIGHT

Step-down (Buck) DC-DC Converter



Push-pull DC-DC Converter



ORDERING INFORMATION

X
↓
Source:
X = X-REL Semi

TR
↓
Process:
TR = HiTemp, HiRel

30
↓
Part family

010
↓
Part number

Product Reference	Temperature Range	Package	Pin Count	Marking
XTR30010-TD	-60°C to +230°C	Tested bare die		
XTR30011-D	-60°C to +230°C	Ceramic side braze DIP	24	XTR30011
XTR30011-S	-60°C to +230°C	Ceramic SOIC	24	XTR30011
XTR30014-D	-60°C to +230°C	Ceramic side braze DIP	24	XTR30014
XTR30014-S	-60°C to +230°C	Ceramic SOIC	24	XTR30014
XTR30015-D	-60°C to +230°C	Ceramic side braze DIP	8	XTR30015
XTR30016-D	-60°C to +230°C	Ceramic side braze DIP	8	XTR30016
XTR30017-FE	-60°C to +230°C	Gull-wing flat pack with ePad	10	XTR30017
XTR30018-S	-60°C to +230°C	Ceramic SOIC	16	XTR30018

Other packages and packaging configurations possible upon request. For some packages or packaging configurations, MOQ may apply.

AVAILABLE FUNCTIONALITIES FOR EACH PACKAGING FAMILY

Supported converter architectures for given packaging option

	Pin Count	Buck	Boost	Buck-boost	Flyback	Push-pull
XTR30010 (bare die)	—	✓	✓	✓	✓	✓
XTR30011	24	✓	✓	✓	✓	
XTR30014	24		✓	✓	✓	✓
XTR30015	8	✓				
XTR30016	8		✓	✓	✓	
XTR30017	10	✓	✓	✓	✓	
XTR30018	16	✓	✓	✓	✓	✓

Packaging Configurations with OCPMode=1

Functionality	Packaging Option		
	XTR30011	XTR30015	XTR30018
Tunable clock with external R or C or possible synchronization on an external clock	Yes	No	Yes
Internal saw-tooth resistor	Yes	Yes	No
Adjustable saw-tooth slope	Yes ¹	No ¹	Yes ^{1,2}
Available PGood output flag	Yes	No	Yes
Possible automatic synchronous/asynchronous mode transition (with or without pulse skipping)	Yes	No	Yes
Possible “synchronous only” mode (except during startup)	Yes	Yes	No
Possible pulse skipping in steady state (i.e. after startup period)	Yes	No	Yes
Adjustable pulse skipping threshold	Yes	No	No
Low power mode (VDD=4V) availability with possible bypass of the internal LDO by an external 5V	Yes	No	No
Chip enable/disable	Yes	Yes	Yes
Adjustable soft-start slope or possible tracking	Yes	No	No
Possible over current protection using the OCS pin ³	Yes	No	Yes
Possible adjustable limitation of the max duty cycle ^{4,5}	Yes	No	No
Separate GND and PGND pins	Yes	No	Yes
Separate VDD and PVDD pins	Yes	No	No
Compact packaging (number of pins)	24	8	16

Packaging Configurations with OCPMode=0

Functionality	Packaging Option				
	XTR30011	XTR30014	XTR30016	XTR30017	XTR30018
Tunable clock with external R or C or possible sync on an external clock	Yes	Yes	No	No	Yes
Internal saw-tooth resistor	Yes	Yes	Yes	No	No
Adjustable saw-tooth slope	Yes ¹	Yes ¹	No ¹	Yes ^{1,2}	Yes ^{1,2}
Available PGood output flag	Yes	Yes	No	No	Yes
Possible turn off of the LDrv(ADrv) output pad if not used for power saving ⁵	Yes	Yes	Yes	Yes	No
Possible pulse skipping in steady state (i.e. after startup period)	Yes	Yes	No	No	Yes
Adjustable pulse skipping threshold	Yes	Yes	No	No	No
Low power mode (VDD=4V) availability with possible bypass of the internal LDO by an external 5V	Yes	Yes	No	No	No
Chip enable/disable	Yes	Yes	Yes	Yes	Yes
Adjustable soft start slope or possible tracking	Yes	Yes	No	No	No

Possible over current protection using the OCS pin ³	Yes	Yes	Yes	Yes	Yes
Possible adjustable limitation of the max duty cycle ^{4,5}	Yes	Yes	No	No	No
Possible interleave mode	No	Yes	No	No	Yes
Separate GND and PGND pins	Yes	Yes	No	No	Yes
Separate VDD and PVDD pins	Yes	24	No	No	No
Compact packaging (number of pins)	24	16	8	10	16

¹ See “Saw-tooth signal generation” and “PWM signal generation” in section “Theory of Operation”.

² In this packaging configuration current mode control can be achieved by the addition of few external components.

³ This is the main overcurrent protection, based on a sense resistor from the low-side switch (or asynchronous rectifier) to PGND. A second short circuit protection associated to the DCLimit terminal is also present. The short-circuit protection related to DCLimit is based in detecting if the error amplifier is always working on its linear regime. This second protection is only efficient for strong short-circuit conditions. For weak over current values, it will not trig or very lately, so that the power part could be damaged if the main short circuit protection is not active.

⁴ Internally, DCLimit is set to 2/5VDD. Depending on the clock period and the saw-tooth slope, the maximum duty cycle can be limited intrinsically. The range is however quite limited. Also, the saw-tooth slope and frequency are usually set by loop gain and stability constraints. Therefore, we consider here only the possibility of an independent control of the maximum duty-cycle, based on the availability of the DCLimit pin.

⁵ DCLimit functionality is also used as a short-circuit protection. See “Over-current protection” in the “Theory of Operation” section.

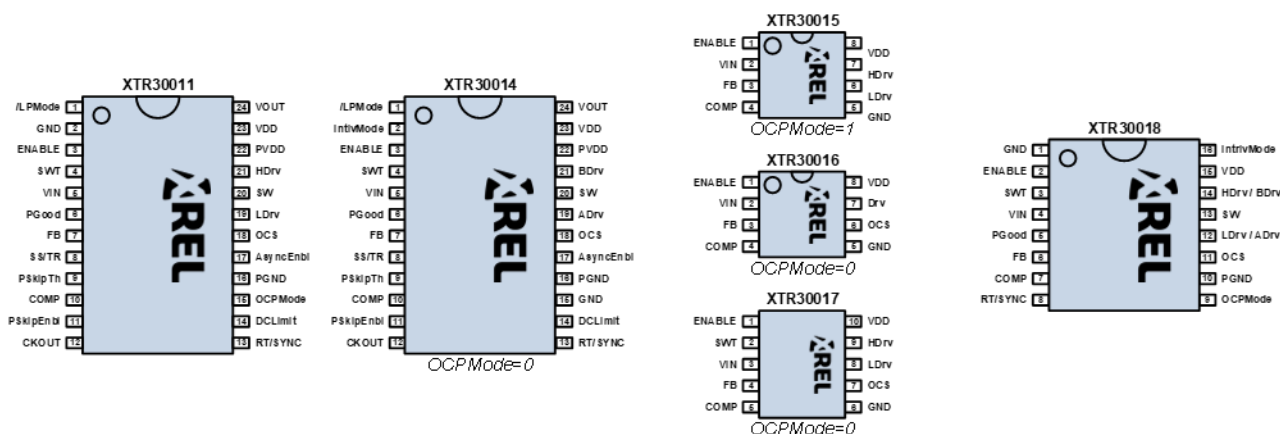
⁶ LDrv is OFF when OCPMode and AsyncEnbl are both low.

ABSOLUTE MAXIMUM RATINGS

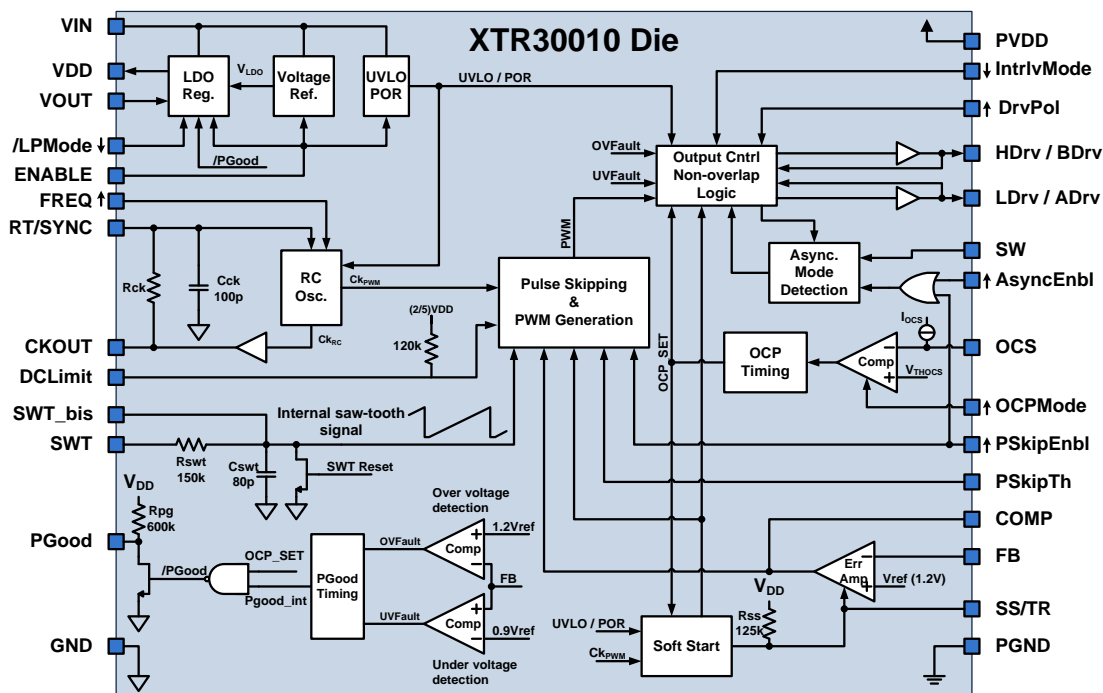
Voltage on VIN, SWT, OCS, SW or ENABLE to ground	-0.5 to 60V
Voltage on any pin to ground	-0.5 to 6.0V
Storage Temperature Range	-70°C to +230°C
Operating Junction Temperature Range	-70°C to +300°C
ESD Classification	1kV HBM MIL-STD-883

Caution: Stresses beyond those listed in “ABSOLUTE MAXIMUM RATINGS” may cause permanent damage to the device. These are stress ratings only and functionality of the device at these or any other condition beyond those indicated in the operational sections of the specifications is not implied. Exposure to “ABSOLUTE MAXIMUM RATINGS” conditions for extended periods may permanently affect device reliability.

PACKAGING



BLOCK DIAGRAM



Arrows aside pad names indicate whether the input is internally pulled up or down by default.

Die-level block diagram showing all available functionalities and bond-pads. Different functionalities are available depending upon packaging configuration. Carefully read sections “Available Functionalities for Each Packaging Family” and “Theory of Operation” in order to select the packaging option that best fits your needs.

PIN DESCRIPTION

Name	Description	Pin Number											
		XTR30011		XTR30014		XTR30015		XTR30016		XTR30017		XTR30018	
/LPMode	Operation in low-power mode when driven LOW.	1	↓ ¹	1	↓	—	↑	—	↑	—	↑	—	↑
IntrlvMode	Operation in interleaved mode when driven HIGH.	—	↓	2	↓	—	↓	—	↓	—	↓	16	↓
GND	Ground.	2		—		—		—		—		1	
ENABLE	Enables PWM controller operation when driven HIGH. When driven low, the part remains in shutdown mode.	3		3		1		1		1		2	
SWT	Saw-tooth slope programming terminal. Connect to a positive supply directly or through an external resistor. Connection to VIN provides supply feed forward compensation. To connect SWT to VIN, use a minimum 100Ω resistor.	4		4		2		2		2		3 ²	
SWT_bis	Direct access to the saw-tooth slope programming capacitor allowing current mode control. Connect to a positive supply through a current generator or an external resistor.	—		—		—		—		2		3 ²	
VIN	Supply voltage. A minimum capacitor of 0.1μF must be connected from this node to ground. This pin supplies the internal voltage reference and linear regulator.	5		5		2		2		3		4	
PGood	Power good flag. Pulled-down when FB is outside a given range or in an overcurrent event and pulled-up to VDD (internal 600kΩ resistor) after soft-start sequence has successfully finished. Pull-up can be reinforced by connecting an external resistor between PGood and VDD.	6	↑	6	↑	—	↑	—	↑	—	↑	5	↑
FB	Feedback pin of the control loop. Inverting input of error amplifier.	7		7		3		3		4		6	
SS/TR	Soft-start and track input. An external resistor from this node to ground can be used to increase the soft-start period. When driven by an external analog voltage lower than Vref, voltage tracking mode can be used.	8		8		—		—		—		—	
PSkipTh	Pulse-skipping threshold. Sets the minimum error amplifier output that makes the controller enter in pulse-skipping mode (PSkipEnbl=1).	9		9		—		—		—		—	
COMP	Output of error amplifier. This node should not see any resistive load with a DC path.	10		10		4		4		5		7	
PSkipEnbl	Enables operation in pulse-skipping mode when driven HIGH.	11	↑	11	↑	—	↓	—	↓	—	↓	—	↑
CKOUT	Output of internal oscillator. It can be used to synchronize cascaded controllers.	12		12		—		—		—		—	
RT/SYNC	Sets the switching frequency. When driven by an external square signal, synchronizes the internal oscillator to this signal. Any external parasitic capacitance on this node decreases the nominal frequency.	13		13		—		—		—		8	
DrvPOL	Sets the operating polarity of the output drivers. When driven HIGH, HDrv is HIGH when active. When driven LOW, HDrv is LOW when active. Only available at bare die level or in packaging upon request.	—	↑	—	↑	—	↑	—	↑	—	↑	—	↑
DCLimit	PWM duty-cycle limiting function. It fixes the upper limit of the error amplifier output "COMP". If COMP exceeds this limit, the input of the error amplifier will be internally clamped to the voltage present on DCLIM. Clamping level can be adjusted with an external resistor to GND. Internally set to 2/5 of VDD across a 100k resistor. Leave it floating for default mode or connect to VDD to disable its functionality.	14		14		—		—		—		—	
OCPMode	Sets the polarity of the over-current protection threshold. Negative when driven HIGH (buck) and positive when driven LOW (boost, flyback, push-pull).	15	↑	—	↓	—	↑	—	↓	—	↓	9	↑
FREQ	Sets the operating frequency range of the internal oscillator. FREQ=0 => lower range; FREQ=1 => upper range. Only available at bare die level or in packaging upon request.	—	↑	—	↓	—	↑	—	↓	—	↓	9	↑
GND	Ground.	—		15		5		5		6		—	
PGND	Power ground used by the output drivers. Set to same potential than GND through a star-like connection of the respective planes.	16		16		5		5		6		10	
AsyncEnbl	When OCPMode=1, AsyncEnbl allows operation in asynchronous mode when driven HIGH. When driven LOW, the controller operates only in synchronous mode except if pulse-skipping mode is active. AsyncEnbl also	17	↑	17	↑	—	↓	—	↓	—	↓	—	↑

	interacts with OCPMode in order to control activity of LDrv. Read a more detailed description of the functionality of this pin in the "Internal Blocks and Functional Features" section of this datasheet.											
OCS	Sensing input of the over-current protection, referred to PGND. Parasitic capacitance between this node and noisy nodes must be minimized at PCB level. In buck (step-down) mode (OCPMode=1), connect OCS to VDD if not used. In boost, flyback, push-pull modes (OCPMode=0), connect OCS to GND if not used.	18	18	2	6	7	11					
LDrv / ADrv	Output for the synchronous rectifier transistor driver. In interleaved mode, ADrv is the output having the first activity.	19	19	6	—	8	12					
SW	Feedback from switching node for operation in asynchronous mode, if enabled. It is also used for current sense sampling in buck mode (OCPMode=1). Connect to VIN or VDD or keep floating if not used. Read a more detailed description of the functionality of this pin in the "Internal Blocks and Functional Features" section of this datasheet.	20	20	—	↑	—	↑	—	↑	13		
HDrv / BDrv	Output for the main switch transistor driver. In interleaved mode, BDrv is the output having the second activity.	21	21	7	7	9	14					
PVDD	Power supply of the output buffers. A minimum capacitor of 0.1μF must be connected from this node to ground.	22	22	8	8	10	15					
VDD	Output of the internal linear regulator. This pin supplies the internal circuitry and can supply PVDD if externally connected. A minimum capacitor of 0.1μF must be connected from this node to ground.	23	23	8	8	10	15					
VOUT	Auxiliary input to bypass the internal linear regulator in low-power mode whenever an external 5V supply exists. Connect to VDD or leave floating if not used.	24	24	—	—	—	—					

¹ Arrows aside pin numbers indicate if the pin is internally pulled up or down for the given packaging option.

² The internal resistor R_{SWT} is shorted (SWT_bis connected to SWT) in packaging options XTR30017 and XTR30018. An external saw-tooth resistor is mandatory.

RECOMMENDED OPERATING CONDITIONS

Parameter	Min	Typ	Max	Units
Supply voltage V_{IN}	6 ¹		50	V
Voltage on SWT, ENABLE, SW ² , OCS ²	0		V_{IN}	V
Voltage on digital inputs to GND. /LPMODE, PSkipEnbl, AsyncEnbl, IntrlMode, OCPMode, DrvPOL, FREQ	0		V_{DD}	V
Voltage on VOUT input to GND.	4.5	5	5.5	V
Voltage on DCLimit	0.5		2 ³ (internally set)	V
Voltage on PSkipTh ⁴	0.2 (internally set)		DCLimit - 0.3	V
Operating Frequency F_o FREQ=1 FREQ=0	50 ⁵	520 180	1000 ⁵	kHz
Case Temperature ⁶ T_c	-60		230	°C

¹ Operation with input voltage 5V possible with bypassing of the internal linear regulator (V_{IN} shorted to VDD).

² During transient operation, SW and OCS can reach values under 0V and above V_{IN} . Extreme values are limited by internal clamping diodes to GND and to V_{IN} .

³ Theoretically, DCLimit can be set to any voltage from 0.5V (internal threshold) to VDD. DCLimit above 2V has no effect on the maximum duty cycle limitation. The default threshold if DCLimit leave floating is $2/5V_{DD}$. DCLimit can be connected to VDD to deactivate its functionality (deactivation of the volt-second clamp).

⁴ PSkipTh must be at least 300mV below DCLimit. PSkipTh has an internally set value of 200mV.

⁵ The frequency of the internal clock generator can be changed by the external addition of a capacitors or a resistor.

⁶ Operation beyond the specified temperature range is achieved. The -60°C to +230°C range for the case temperature is considered for the case where no current is externally drawn from pin VDD, other than to supply the XTR30010 part.

ELECTRICAL SPECIFICATIONS

Unless otherwise stated, specification applies for $V_{IN}=6V$ to $50V$, $V_{DD}=5V$, $-60^{\circ}C < T_c < 230^{\circ}C$.

Parameter	Condition	Min	Typ	Max	Units
Reference Voltage					
Internal Feedback Reference Voltage V_{REF}	$V_{IN}=10V$, $T_c=85^{\circ}C$.	1.186	1.210	1.234	V
Drift with Temperature $(\Delta V_{REF}/V_{REF})/\Delta T$	$V_{IN}=10V$, ΔT from $-60^{\circ}C$ to $+230^{\circ}C$ $\Delta V_{REF}=V_{REF_Max}(\Delta T)-V_{REF_min}(\Delta T)$	20	60	100	ppm/ $^{\circ}C$
Line regulation ΔV_{REF}	V_{IN} sweep (ΔV_{IN}) from $6V$ to $50V$ $\Delta V_{REF}=V_{REF_Max}(\Delta V_{IN})-V_{REF_min}(\Delta V_{IN})$ $T_c=85^{\circ}C$ $T_c=230^{\circ}C$		6.7 10.7	13 17	mV
Supply Current					
Stand-by Supply Current I_{VNSB}	ENABLE=0V. $V_{IN}=50V$ (worst case) $T_c=85^{\circ}C$ $T_c=230^{\circ}C$		25 52	40 70	μA
Dynamic Supply Current I_{VIND}	$F_O=520kHz$. $C_{load}=50pF$ on HDrv and LDrv, synchronous mode. $T_c=230^{\circ}C$ and $V_{IN}=50V$ (worst case)		2.7	3.2	mA
Supply Current Low-Power Mode I_{VINLP}	$V_{DD}=4V$ (/LPMode=0), $F_O=520kHz$. $C_{load}=50pF$ on HDrv and LDrv, synchronous mode, $V_{IN}=50V$ (worst case).		2.3	2.8	mA
Supply Current Low-Power Mode with External Supply I_{VINES}	5V supplied by external source through pin V_{OUT} and /LPMode=0, $F_O=520kHz$. $C_{load}=50pF$ on HDrv and LDrv, synchronous mode, $V_{IN}=50V$ (worst case).		0.58	0.75	mA

ELECTRICAL SPECIFICATIONS (CONTINUED)

Unless otherwise stated, specification applies for $V_{IN}=6V$ to $50V$, $V_{DD}=5V$, $-60^{\circ}C < T_c < 230^{\circ}C$.

Parameter	Condition	Min	Typ	Max	Units
Voltage Regulator					
Output Voltage V_{DD}	$V_{IN}=10V$, $I_{LOAD}=1mA$, $T_c=85^{\circ}C$ /LPMODE=0 (default) ¹ /LPMODE=1	3.9 4.875	4 5	4.1 5.125	V
Drift with Temperature $(\Delta V_{DD}/V_{DD})/\Delta T$	$V_{IN}=10V$, $I_{LOAD}=1mA$ $\Delta V_{DD}=V_{DD_MAX}(\Delta T)-V_{DD_MIN}(\Delta T)$	20	60	100	ppm/ $^{\circ}C$
Line regulation $\Delta V_{DD}/V_{DD}$	V_{IN} sweep (ΔV) from 6V to 50V, $V_{DD}=4V$ or 5V, $I_{LOAD}=1mA$, $T_c=230^{\circ}C$ (worst case).		0.73	1.30	%
Load regulation $\Delta V_{DD}/\Delta I_{DD}$	$V_{IN}=10V$, $I_{LOAD}=1mA$ to 20mA $T_c=-60^{\circ}C$ $T_c=230^{\circ}C$	-1.8 -3.5	-1.3 -2.6		mV/mA
Maximum Output Current I_{DDMAX}	$V_{IN}=10V$, $V_{DD}=5V$ (/LPMODE=1). See Figure 7. $T_c=85^{\circ}C$ $T_c=230^{\circ}C$	35 20	45 25		mA
	$V_{IN}=10V$, $V_{DD}=4V$ (/LPMODE=0). See Figure 8. $T_c=85^{\circ}C$ $T_c=230^{\circ}C$	40 25	55 35		mA
PWM Enable Voltage V_{ENON}	ENABLE going up. Worst case at $T_c=-60^{\circ}C$		1.8	2.2	V
PWM Disable Voltage V_{ENOFF}	ENABLE going down. Worst case at $T_c=230^{\circ}C$	0.6	0.9		V
ENABLE Hysteresis ² V_{ENH}	ENABLE going up then down	0.2	0.4		V
ENABLE Current I_{EN}	$V_{EN}=0V$ $V_{EN}=5V$	-6 -5		0 1	μA
Load Capacitance ^{2,3} C_{VDD}	Allowed value.	0.3	1	10	μF
Under Voltage Lockout					
V_{DD} Start Voltage V_{UVLOR}	V_{IN} going up.	3.8	4	4.2	V
V_{DD} Stop Voltage V_{UVLOF}	V_{IN} going down.	3.4	3.7	3.9	V
V_{DD} Start-stop Hysteresis ² V_{UVLOH}	V_{IN} going up then down.	0.25	0.40	0.55	V
Soft Start / Tracking					
Equivalent Resistance ² R_{SS}	$T_c=-60^{\circ}C$ $T_c=85^{\circ}C$ $T_c=230^{\circ}C$		145 113 96		k Ω
Tracking Voltage Range ⁴ $V_{SS/TR}$	$V_{SS/TR}$ must remain below the internal Vref (1.2V).	0.25		1.0	V
Tracking Offset on FB ² $V_{FB-SS} = V_{FB} - V_{SS/TR}$	$V_{SS/TR}=0.5V$ $T_c=-60^{\circ}C$ $T_c=230^{\circ}C$	-20 -60	-30 -75	-40 -90	mV
Oscillator					
Free Running Frequency F_o	$T_c=85^{\circ}C$. No capacitor connected to RT/SYNC. XTR30011 (FREQ=1), XTR30018 (OCPMode=1) XTR30014 (FREQ=0), XTR30018 (OCPMode=0)	450 140	510 175	570 210	kHz
	$T_c=85^{\circ}C$. RT/SYNC not available on package. XTR30015 (FREQ=1) XTR30016, XTR30017 (FREQ=0)	460 150	520 185	580 220	kHz
Oscillator accuracy	Oscillator running from internal components.		± 6		%
Adjustable Range ²	With external components.	50		1000	kHz
Recommended Duty Cycles of External Clock	F=520kHz	15		85	%
Minimum Achievable Off-time ² t_{off_Min}	$V_{DD}=5V$ (/LPMODE=1). $T_c=-60^{\circ}C$ $T_c=230^{\circ}C$		220 160		ns
	$V_{DD}=4V$ (/LPMODE=0). $T_c=-60^{\circ}C$ $T_c=230^{\circ}C$		240 180		ns
CKOUT Output Strength ² I_{CKOUT}	$V_{DD}=5V$ (/LPMODE=1), $T_c=230^{\circ}C$		4		mA

¹ XTR30010 parts start-up with $V_{DD}=5V$ even if low-power mode is enabled (/LPMODE=0 or floating). Transition from $V_{DD}=5V$ to $V_{DD}=4V$ occurs when PGood is asserted.

² Guaranteed by design and characterization data only. Not tested in production.

³ VDD must be externally connected to PVDD. The actual load capacitance is the total capacitance connected to VDD and PVDD.

⁴ In tracking mode the PWM controller operates in asynchronous mode, except if interleaved mode is active (IntrlvMode=1).

ELECTRICAL SPECIFICATIONS (CONTINUED)

Unless otherwise stated, specification applies for $V_{IN}=6V$ to $50V$, $V_{DD}=5V$, $-60^{\circ}C < T_c < 230^{\circ}C$.

Parameter	Condition	Min	Typ	Max	Units
Saw-tooth Slope Generator					
Internal Saw-tooth Resistor ⁵ R_{SWT}	XTR30010-TD, XTR30011, XTR30014, XTR30015, XTR30016 XTR30017, XTR30018		150 0 ¹		k Ω
Internal Saw-tooth Capacitor ⁵ C_{SWT}			80		pF
Allowed saw-tooth voltages V_{SWT}		4V		V_{IN}	
Allowed current through SWT_bis terminal ²			200		μA
Pulse-skipping					
PSkipTh Pull-up Current ³ I_{PSTH}	$T_c = -60^{\circ}C$ $T_c = 230^{\circ}C$		11.5 13.1		μA
PSkipTh Internal Resistance to GND ³ R_{PSTH}		17	20	23	k Ω
Recommended Range on PSkipTh Terminal ⁴ V_{PSTH}		0.2		1	V
Internal PSkipTh Offset ^{5,6} V_{PSOFF}		50	160	250	mV
Minimum Recommended On-time t_{ONPS}	PSkipEnbl=1.		50		ns
Duty-cycle limit (DCLimit)					
Internal DCLimit Resistance to VDD ⁵ R_{DCLIMIT}	$T_c = -60^{\circ}C$ $T_c = 230^{\circ}C$	130 81	145 90	160 99	k Ω
Internal DCLimit Threshold V_{DCLIMIT}	Default value when left floating. Recommended operational range using an external resistor to ground.	-2% 0.5 ⁷	0.4VDD 	+2% 0.4VDD ⁸	V
Overcurrent Protection					
OCS Current I_{OCS}	$V_{DD}=5V$ (/LPMode=1). $T_c = -60^{\circ}C$ $T_c = 85^{\circ}C$ $T_c = 230^{\circ}C$		37 48 56		μA
	$V_{DD}=4V$ (/LPMode=0). $T_c = -60^{\circ}C$ $T_c = 85^{\circ}C$ $T_c = 230^{\circ}C$		30 39 45		μA
	$V_{DD}=5V$ (/LPMode=1). OCPMode = HIGH (Buck) OCPMode = LOW (Boost, Flyback, Push-pull)		15 370		mV
OCS Threshold Voltage V_{THOCS}	$V_{DD}=4V$ (/LPMode=0). OCPMode = HIGH (Buck) OCPMode = LOW (Boost, Flyback, Push-pull)		15 290		mV

¹ The internal resistor R_{SWT} is shorted (SWT_bis connected to SWT) in packaging options XTR30017 and XTR30018.

² The reason for this current limit is to guarantee that the SWT_bis node is completely discharged at the end of the saw-tooth signal.

³ In production, only the voltage on PSkipTh (product $R_{PSTH} \times I_{PSTH}$) is verified.

⁴ It shall always be lower than the voltage on DCLimit by at least 300mV. Note that internally, V_{PSOFF} (150mV approx.) is removed from this voltage before comparison with the saw-tooth. The crossing defines the minimum t_{on} in pulse skipping mode.

⁵ Guaranteed by design and characterization data only. Not tested in production.

⁶ The internal effective voltage for pulse skipping operation is the voltage on the PSkipTh terminal minus V_{PSOFF} .

⁷ It shall always be higher than the voltage on PSkipTh pin by at least 300mV.

⁸ DCLimit can be connected to VDD in order to inhibit this functionality.

ELECTRICAL SPECIFICATIONS (CONTINUED)

Unless otherwise stated, specification applies for $V_{IN}=6V$ to $50V$, $V_{DD}=5V$, $-60^{\circ}C < T_c < 230^{\circ}C$.

Parameter	Condition	Min	Typ	Max	Units
Error Amplifier					
Input Bias Current ² I_b	$T_c=230^{\circ}C$, $V_{IN}=50V$ (worst case).		50	150	nA
Sinking Output Current ² I_{osnk}	$T_c=-60^{\circ}C$ $T_c=85^{\circ}C$ $T_c=230^{\circ}C$		65 115 170		μA
Sourcing Output Current ² I_{osrc}	$V_{IN}=6V$ (worst case) $T_c=-60^{\circ}C$ $T_c=85^{\circ}C$ $T_c=230^{\circ}C$		25 19 14		mA
DC Gain ^{1, 2} A_o	$R_L=\infty$		105		dB
Gain Bandwidth Product ² GBW	$C_L=90pF$	1.1	2		MHz
Digital Inputs (/LPMode, PSkipEnbl, AsyncEnbl, DrvPOL, IntrlMode, OCPMode)					
HIGH Level Input Voltage V_{T+}	$V_{DD}=5V$ (/LPMode=1). $V_{DD}=4V$ (/LPMode=0).	2.6 2.1	3.1 2.5	3.6 3.0	V
LOW Level Input Voltage V_{T-}	$V_{DD}=5V$ (/LPMode=1). $V_{DD}=4V$ (/LPMode=0).	1.3 0.9	1.9 1.4	2.5 1.9	V
Hysteresis Voltage ($V_{T+}-V_{T-}$) ² V_{Hys}	$V_{DD}=5V$ (/LPMode=1). $V_{DD}=4V$ (/LPMode=0).	0.7	1.1	1.5	V
Pull-down Strength ² I_{PD}	Pulled-down inputs forced to VDD. $V_{DD}=5V$. $T_c=-60^{\circ}C$ $T_c=230^{\circ}C$		60 23	90 45	μA
Pull-up Strength ² I_{PU}	Pulled-up inputs forced to GND. $V_{DD}=5V$. $T_c=-60^{\circ}C$ $T_c=230^{\circ}C$		-75 -36	-100 -55	μA
Output Drivers					
Pull-up Output Resistance ² R_{ONH}	Output sourcing 10mA. Worst case for $V_{IN}=50V$ and $T_c=230^{\circ}C$. See Figure 16. $V_{DD}=5V$ (/LPMode=1).		78	95	Ω
	Output sourcing 10mA. Worst case for $V_{IN}=50V$ and $T_c=230^{\circ}C$. See Figure 15. $V_{DD}=4V$ (/LPMode=0).		83	100	Ω
Pull-down Output Resistance ⁵ R_{ONL}	Output sinking 10mA. $V_{IN}=6V$ to $50V$, $T_c=230^{\circ}C$ (worst case). See Figure 18. $V_{DD}=5V$ (/LPMode=1).		29	45	Ω
	Output sinking 10mA. $V_{IN}=6V$ to $50V$, $T_c=230^{\circ}C$ (worst case). See Figure 17. $V_{DD}=5V$ (/LPMode=1).		33	50	Ω
Peak Sinking Output Current ² I_{pDrv_sink}	$V_{DD}=5V$ (/LPMode=1). $T_c=230^{\circ}C$ (worst case). See Figure 20.	35	45		mA
	$V_{DD}=4V$ (/LPMode=0). $T_c=230^{\circ}C$ (worst case). See Figure 19.	25	35		mA
Peak Sourcing Output Current ² I_{pDrv_source}	$V_{DD}=5V$ (/LPMode=1). Worst case for $V_{IN}=50V$ and $T_c=230^{\circ}C$. See Figure 22.	35	45		mA
	$V_{DD}=4V$ (/LPMode=0). Worst case for $V_{IN}=50V$ and $T_c=230^{\circ}C$. See Figure 21.	25	35		mA
Non-overlap Time ^{2,3} t_{no}	Time from HDrv / LDrv going down to LDrv / Hdrv going up. $V_{DD}=5V$ (/LPMode=1). $T_c=-60^{\circ}C$ $T_c=230^{\circ}C$	30 45	40 60	60 90	ns
	Time from HDrv / LDrv going down to LDrv / Hdrv going up. $V_{DD}=4V$ (/LPMode=0). $T_c=-60^{\circ}C$ $T_c=230^{\circ}C$	35 55	50 75	75 110	ns

¹ The error amplifier is of type Miller OTA. Avoid connecting any resistive load with a DC path.

² Guaranteed by design and characterization data only. Not tested in production.

³ External drivers must have on-off and off-on delays mismatch lower than t_{no} to avoid any shoot-through on the output transistors.

TYPICAL PERFORMANCE

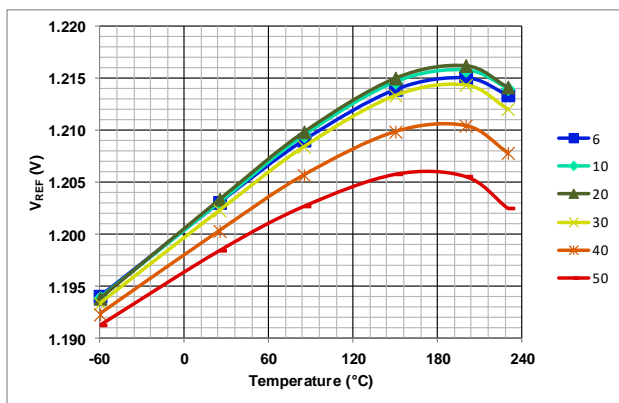


Figure 1. Reference voltage vs temperature for different input voltages (V_{IN}).

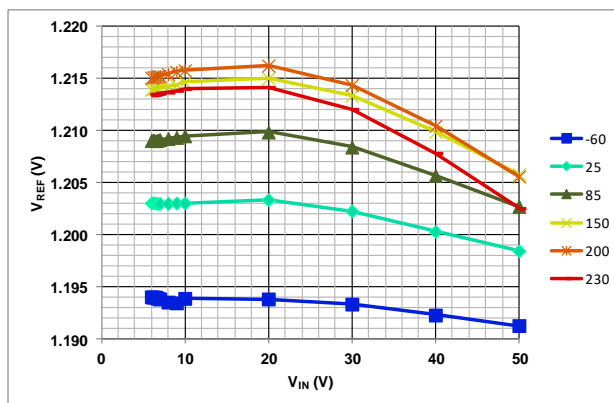


Figure 2. Reference voltage vs input voltage (V_{IN}) for different temperatures.

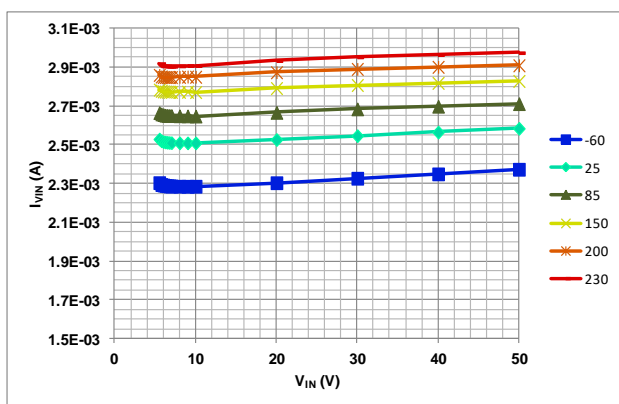


Figure 3. Current through V_{IN} vs input voltage (V_{IN}) for different case temperatures.
Synchronous mode (PSkipEnbl=AsyncEnbl=0), $V_{DD}=5V$ (/LPMODE=1), Freq=520kHz, load capacitance on HDrv and LDrv 200pF.

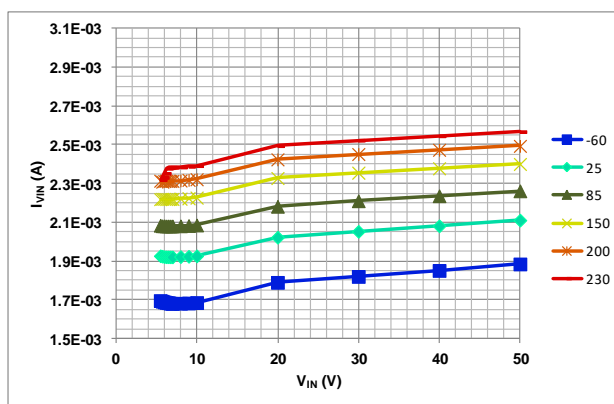


Figure 4. Current through V_{IN} vs input voltage (V_{IN}) for different case temperatures.
Asynchronous mode (AsyncEnbl=1) without pulse slipping (PSkipEnbl=0), $V_{DD}=5V$ (/LPMODE=1), Freq=520kHz, load capacitance on HDrv and LDrv 200pF.

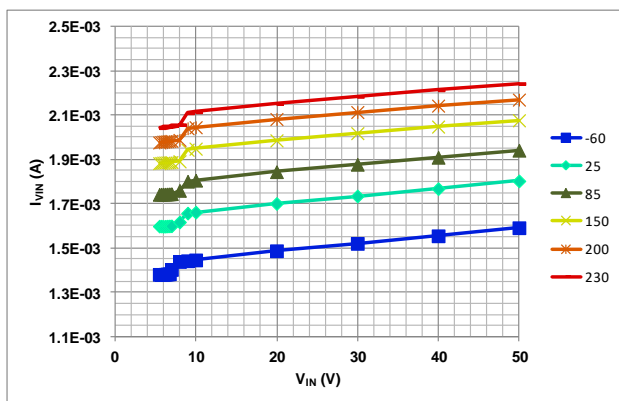


Figure 5. Current through V_{IN} vs input voltage (V_{IN}) for different case temperatures.
Synchronous mode (PSkipEnbl=AsyncEnbl=0), $V_{DD}=4V$ (/LPMODE=0), Freq=510kHz, load capacitance on HDrv and LDrv 200pF.

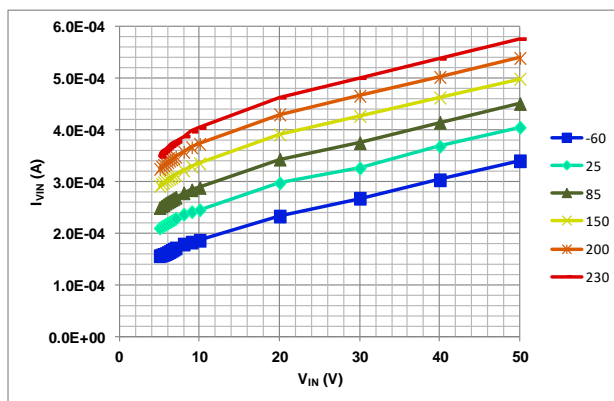


Figure 6. Current through V_{IN} vs input voltage (V_{IN}) for different case temperatures with $V_{DD}=5V$ supplied by external source through pin VOUT.
Synchronous mode (PSkipEnbl=AsyncEnbl=0), /LPMODE=0, Freq=520kHz, load capacitance on HDrv and LDrv 200pF.

TYPICAL PERFORMANCE (CONTINUED)

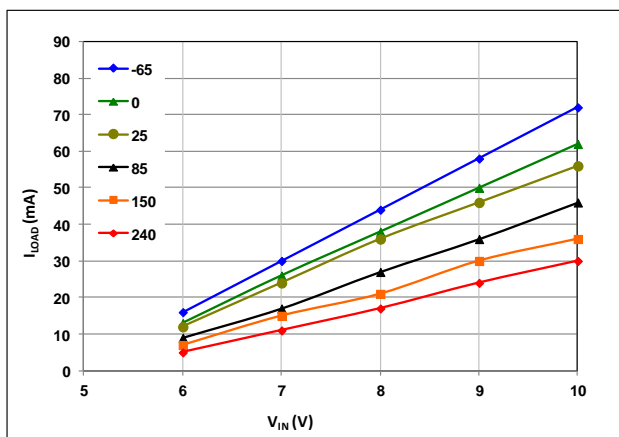


Figure 7. Maximum available output current from VDD vs input voltage (V_{IN}) for several temperatures. $V_{DD}=5V$ (/LPMode=1).

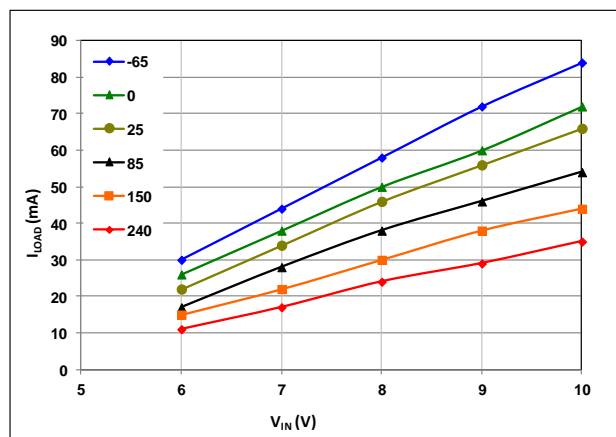


Figure 8. Maximum available output current from VDD vs input voltage (V_{IN}) for several temperatures. $V_{DD}=4V$ (/LPMode=0).

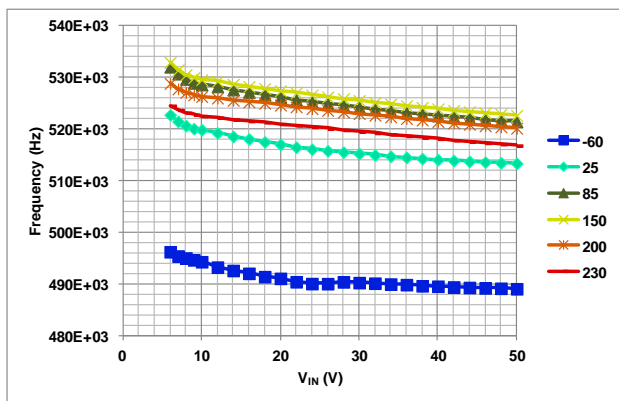


Figure 9. Free running frequency of parts XTR30011, XTR30018 (OCPMode=1) and XTR30015 vs input voltage (V_{IN}) for different case temperatures. $V_{DD}=5V$ (/LPMode=1).

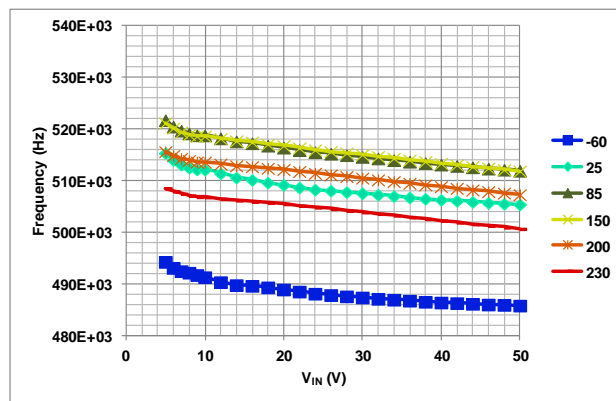


Figure 10. Free running frequency of parts XTR30011, XTR30018 (OCPMode=1) and XTR30015 vs input voltage (V_{IN}) for different case temperatures. $V_{DD}=4V$ (/LPMode=0).

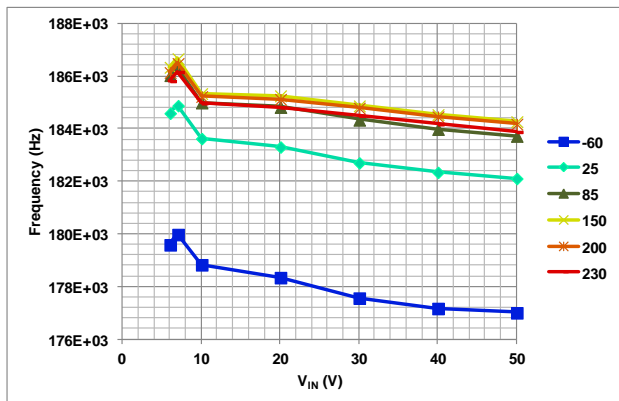


Figure 11. Free running frequency of parts XTR30014 and XTR30016 vs input voltage (V_{IN}) for different case temperatures. $V_{DD}=5V$ (/LPMode=1).

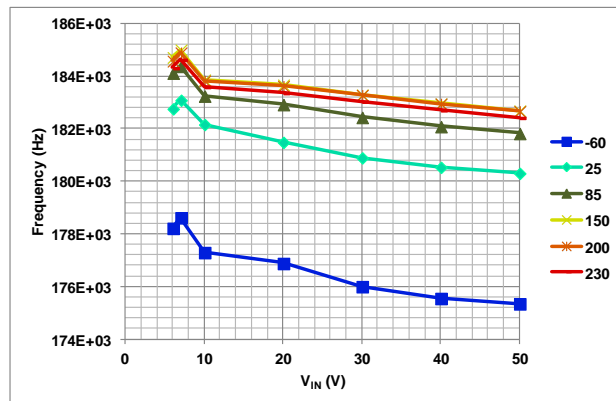


Figure 12. Free running frequency of parts XTR30014 and XTR30016 vs input voltage (V_{IN}) for different case temperatures. $V_{DD}=4V$ (/LPMode=0).

TYPICAL PERFORMANCE (CONTINUED)

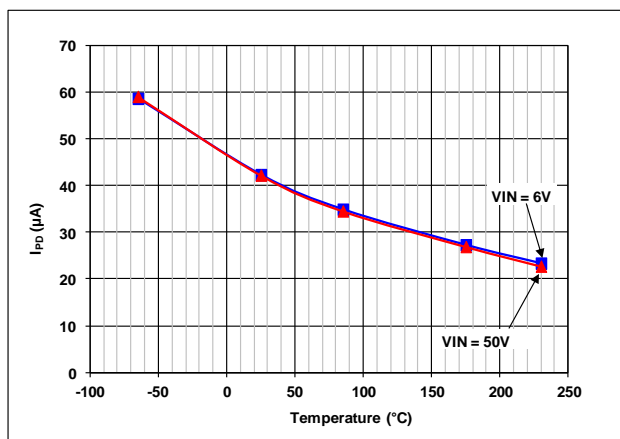


Figure 13. Pull strength of pulled-down digital inputs when pulled to VDD vs temperature. $V_{IN}=6V$ and $50V$, $V_{DD}=5V$.

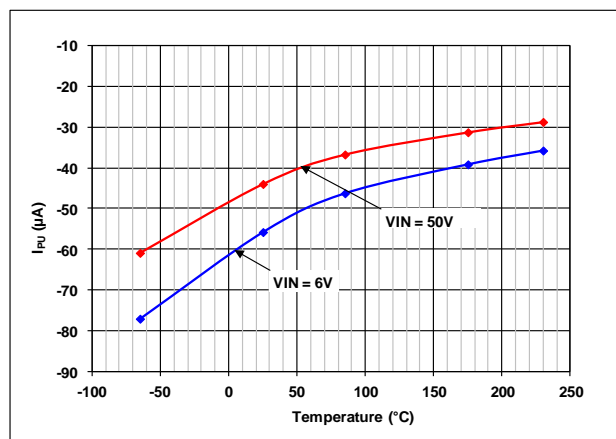


Figure 14. Pull strength of pulled-up digital inputs when pulled to GND vs temperature. $V_{IN}=6V$ and $50V$, $V_{DD}=5V$.

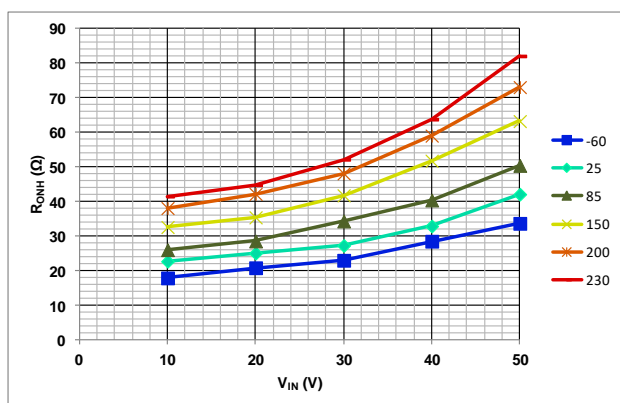


Figure 15. High-state on-resistance of output drivers vs input voltage (V_{IN}) for different case temperatures. Device sourcing 10mA, $V_{DD}=4V$ (/LPMMode=0).

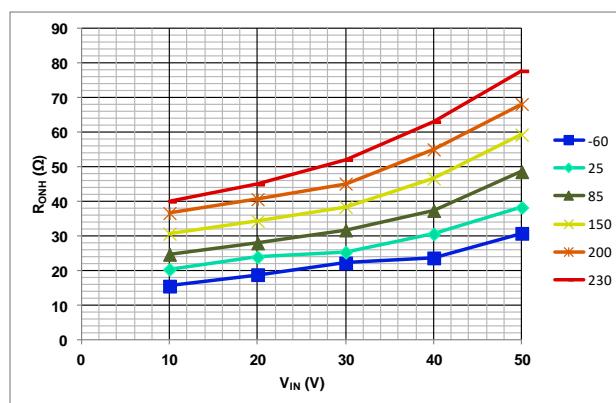


Figure 16. High-state on-resistance of output drivers vs input voltage (V_{IN}) for different case temperatures. Device sourcing 10mA, $V_{DD}=5V$ (/LPMMode=1).

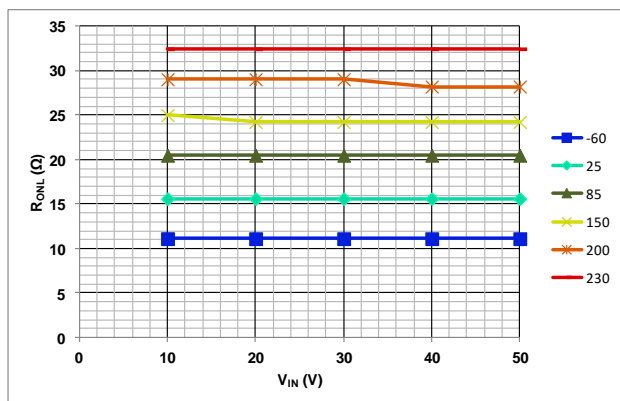


Figure 17. Low-state on-resistance of output drivers vs input voltage (V_{IN}) for different case temperatures. Device sinking 10mA, $V_{DD}=4V$ (/LPMMode=0).

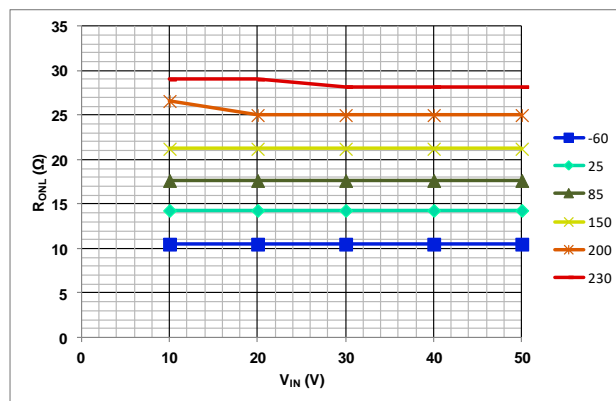


Figure 18. Low-state on-resistance of output drivers vs input voltage (V_{IN}) for different case temperatures. Device sinking 10mA, $V_{DD}=5V$ (/LPMMode=1).

TYPICAL PERFORMANCE (CONTINUED)

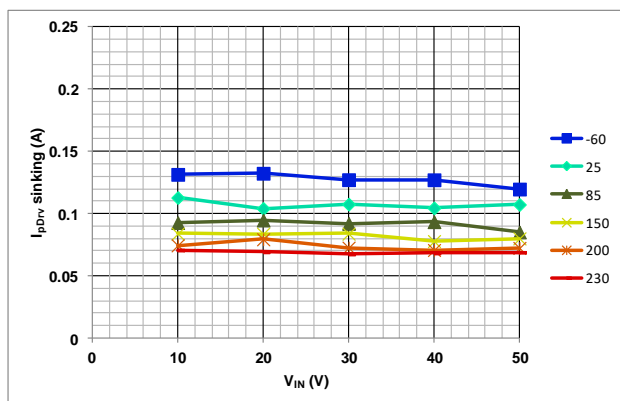


Figure 19. Peak sinking current capability of output drivers vs input voltage (V_{IN}) for different case temperatures. $V_{DD}=4V$ (/LPMode=0).

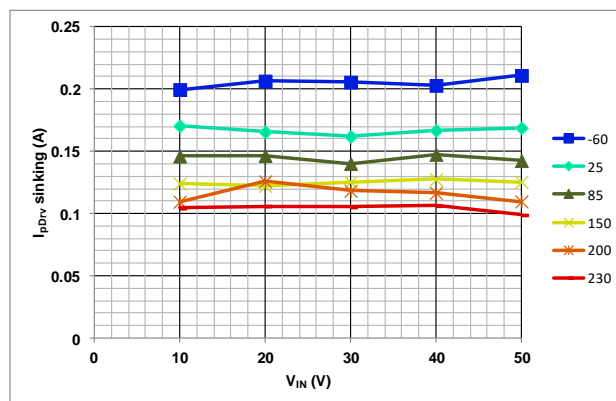


Figure 20. Peak sinking current capability of output drivers vs input voltage (V_{IN}) for different case temperatures. $V_{DD}=5V$ (/LPMMode=1).

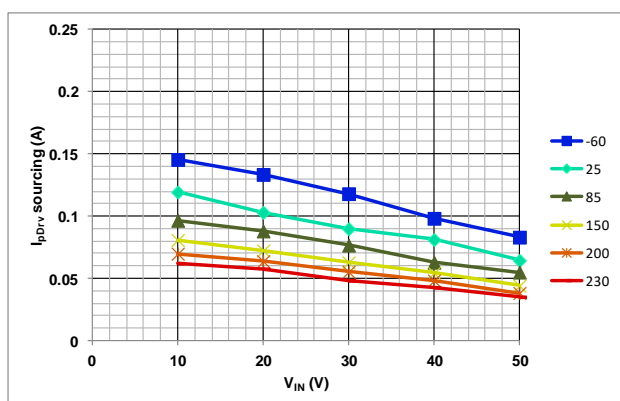


Figure 21. Peak sourcing current capability of output drivers vs input voltage (V_{IN}) for different case temperatures. $V_{DD}=4V$ (/LPMMode=0).

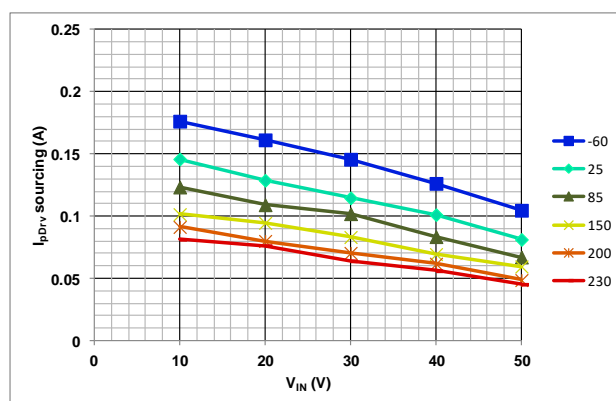


Figure 22. Peak sourcing current capability of output drivers vs input voltage (V_{IN}) for different case temperatures. $V_{DD}=5V$ (/LPMMode=1).

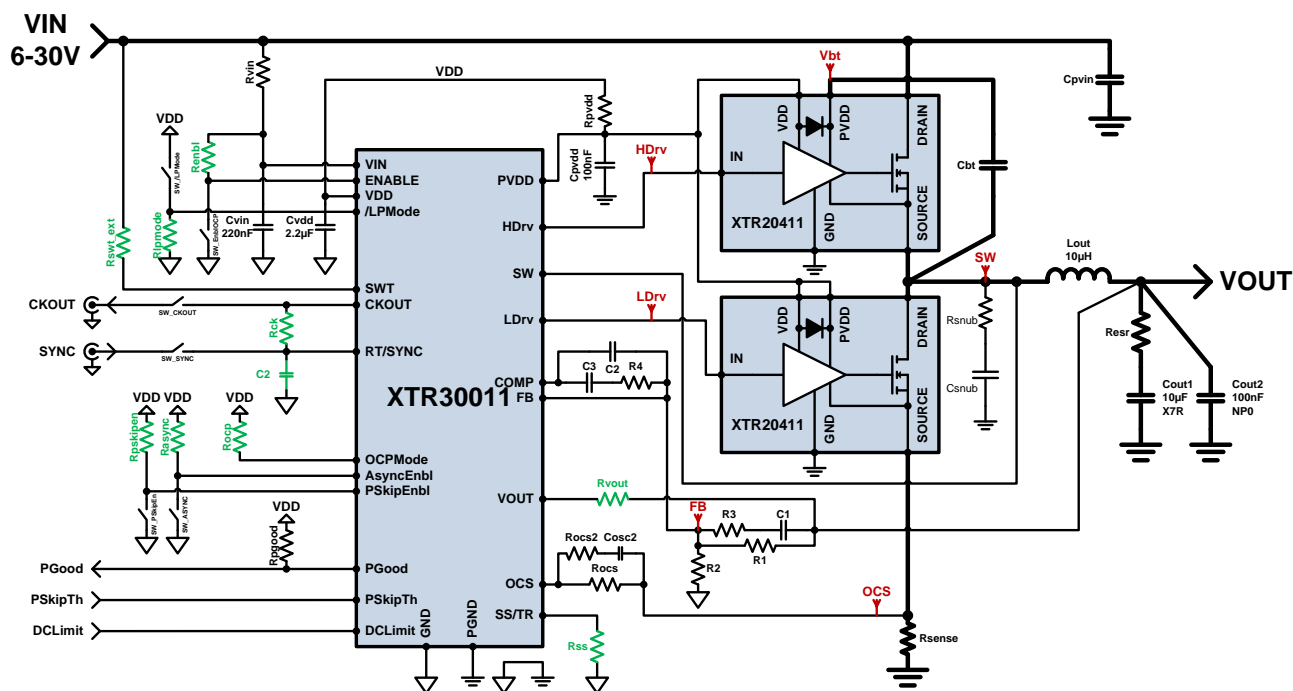


Figure 23. Buck (step-down) test configuration: demo board XTDB30001-2DR.

TYPICAL PERFORMANCE (CONTINUED)

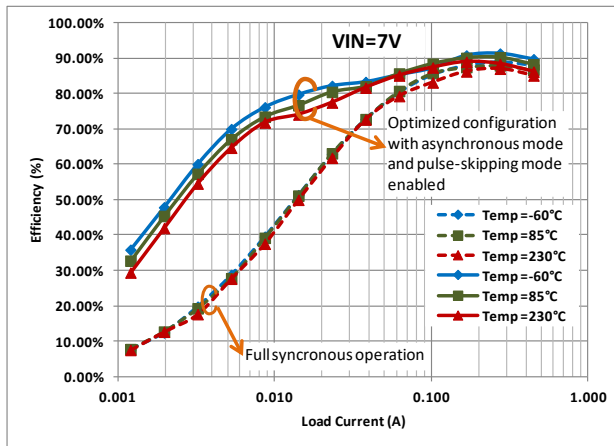


Figure 24. Comparison of full synchronous (dashed lines) and optimized mode with asynchronous mode and pulse-skipping mode enabled (plain lines) for several ambient temperatures. $V_{IN}=7V$. See Figure 23.

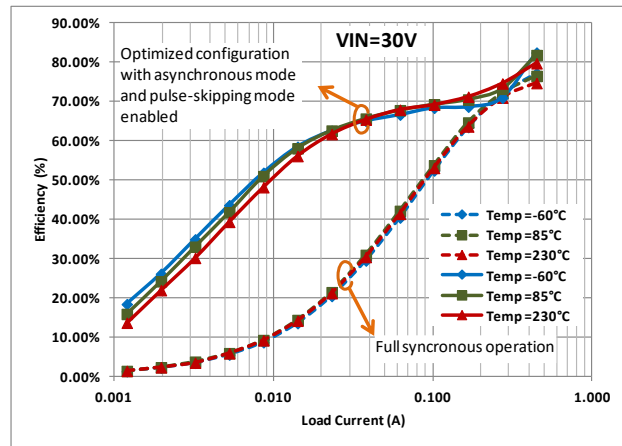


Figure 25. Comparison of full synchronous (dashed lines) and optimized mode with asynchronous mode and pulse-skipping mode enabled (plain lines) for several ambient temperatures. $V_{IN}=30V$. See Figure 23.

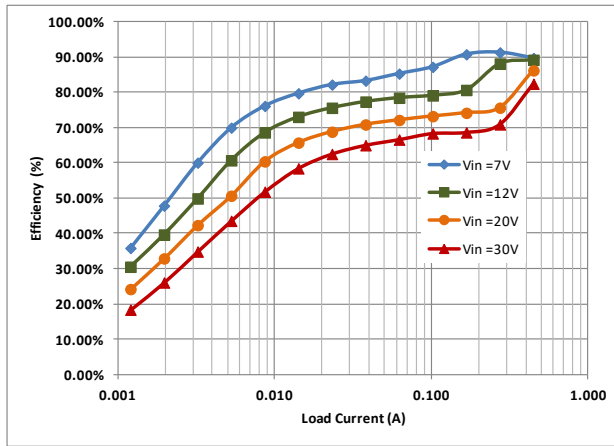


Figure 26. Efficiency vs load current for input voltages for $T_{amb}=-60^{\circ}C$. Buck (step-down) configuration with operation in asynchronous mode and pulse-skipping mode enabled. See Figure 23.

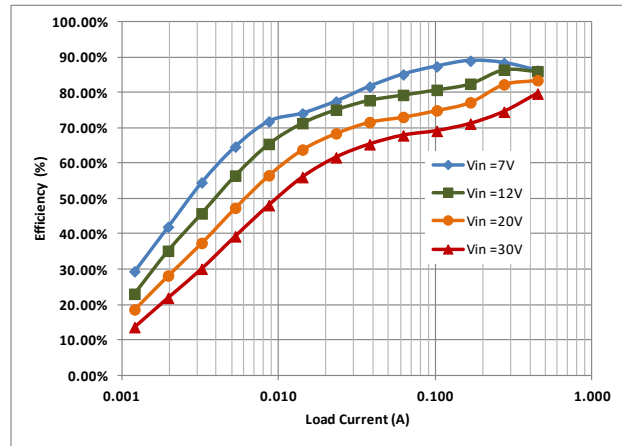


Figure 27. Efficiency vs load current for input voltages for $T_{amb}=230^{\circ}C$. Buck (step-down) configuration with operation in asynchronous mode and pulse-skipping mode enabled. See Figure 23.

THEORY OF OPERATION

Introduction

The XTR30010 is a family of voltage-mode PWM controllers able to operate from -60°C to +230°C, with supply voltages from 6V to 50V. Integrated features include internal voltage reference and linear regulator, under-voltage lockout, synchronizing and externally tunable on-chip oscillator, programmable soft-start period with tracking capabilities, level and polarity programmable hiccup-mode over-current protection, anti-shoot-through, selection of the operating polarity of output drivers, programmable duty cycle limitation, possible interleaved mode, low-power mode, asynchronous mode and pulse skipping mode with adjustable threshold.

Operation Modes

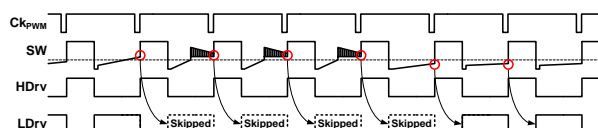
Low-power mode

Low-power mode operation (/LPMODE=0) allows a 5V output voltage from the DC-DC converter to be supplied to the PWM controller through the VOUT terminal. This voltage bypasses the internal linear regulator greatly reducing the current drawn from VIN and hence improving efficiency. Even without an external 5V, the low power mode can be forced. In this case, the PWM will operate under a 4V supply voltage generated by the internal LDO after the startup period. During the startup period, the internal LDO provides a 5V supply to the PWM. Once the PGood flag of the circuit is asserted, the LDO provides a 4V level.

Automatic transition to asynchronous mode

This mode is only available for Buck like converters. This mode is defined when OCPMode=1 (default mode thanks to the internal pull-up). For buck-like converters, automatic transition to asynchronous mode is allowed by setting AsyncEnbl=1 (or floating) or PSkipEnbl=1. In such a case, inversion of the inductor current in buck mode is detected by sensing the voltage on the switching node SW.

When the inductor current inverts during one cycle, conduction of the synchronous rectifier is disabled on the next cycle. When it is detected that the rectifier current does not invert during one cycle, conduction of the synchronous rectifier is allowed in the next cycle. The controller toggles then automatically between synchronous and asynchronous modes depending on output current. This feature allows improving the DCDC efficiency at moderate and low current load.



When OCPMode=0 (i.e. not a Buck-like converter), the AsyncEnbl input, when grounded, turns-off the LDrv output, except in the interleaved mode (IntrlvMode=1) where AsyncEnbl has no effect on the ADrv output.

Pulse-skipping mode (case OCPMode=1)

When pulse-skipping mode is enabled (PSkipEnbl=1), automatic transition from synchronous to asynchronous modes is also forced, even if AsyncEnbl=0. Once the PWM duty-cycle becomes too low (threshold defined by the voltage on PSkipTh), the PWM controller will skip some clock periods. This occurs only at light load currents, where the load capacitance is able to supply the load during several clock periods without receiving energy. As long as the load current is low enough, the PWM will only provide some pulses with a fixed on-time as to keep the average output current. Output pulses are anyway synchronous with the internal clock. Once the load current starts increasing again, the system will skip less and less pulses before going back to asynchronous mode. If the load current further increases, the system will automatically switch to synchronous mode, depending on the voltage polarity on the SW node at the end of each clock period. With OCPMode=1, the controller is always forced to go into asynchronous mode (i.e. LDrv output off) before entering into pulse skipping mode (i.e. LDrv still off and HDrv off for some clock periods).

In all cases, as long as the FB voltage is below 90% of the internal 1.2V reference, the LDrv output is off and the pulse skipping mode is authorized, whatever the PSkipEnbl level.

Pulse-skipping mode (case OCPMode=0)

With OCPMode=0, there is no asynchronous mode detector. The SW input is no longer monitored. If SW is available at the package level, it is recommended to leave SW floating (do not connect SW to VDD or VIN). In this mode HDrv and LDrv outputs work in complementary way (unless interleaved mode is enabled) and the pulse skipping functionality still exists. As long as FB is below 90% of the internal 1.2V reference, the pulse skipping mode is forced, whatever the state of PSkipEnbl. Above this threshold, if PSkipEnbl=1, the LDrv is always the complementary of the HDrv as there is no asynchronous detector for this mode of operation. When OCPMode=0, it is possible to block the LDrv output by setting the AsyncEnbl input to ground. This reduces the dynamic consumption of the controller if the LDrv output is not required.

HDrv and LDrv operating mode

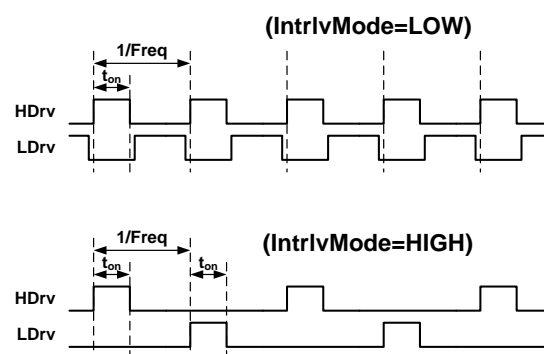
Outputs HDrv and LDrv behave differently depending on the programmable features used. In all cases, both outputs are never ON at the same time.

When in interleaved mode, the internal PWM signal is dispatched alternatively through the ADrv (Ldrv) and BDrv (Hdrv) outputs at every clock period¹. This feature can be used in push-pull converters. In this case, OCPMode should be LOW.

When not in interleaved mode:

- Whenever ENABLE goes low or an under voltage occurs on VDD, both HDrv and LDrv outputs are OFF.
- During start-up or under any loss of regulation, the activity of HDrv and LDrv depends upon the status of control signals.
- In synchronous mode, both HDrv and LDrv are complementary (non-overlapped outputs).
- In asynchronous mode, LDrv is allowed to be OFF depending on the switching span of SW terminal, while only the HDrv is a copy of the internal PWM².
- It is also possible in some cases to turn off permanently the LDrv output in order to reduce the dynamic power consumption if LDrv not needed.³

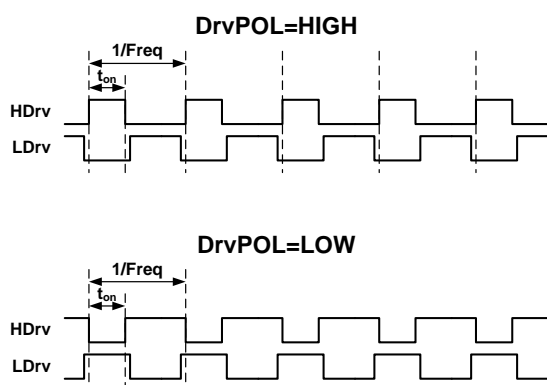
Condition	HDrv / BDrv	LDrv / ADrv
ENABLE=0	Off	Off
FB < 90% of V _{REF} (start-up, loss of regulation) IntrlvMode=0 IntrlvMode=1	Active	Off Active
FB > 120% of V _{REF} (loss of regulation) IntrlvMode=0 IntrlvMode=1	Off	Active Off
Synchronous mode (AsyncEnbl=0, PSkipEnbl=0)	Active	Active
OCPMode=0 and AsyncEnbl=0	Active	Off



¹ At turn on, once VDD goes above the UVLO threshold, the first active output of the interleaved mode is ADrv (LDrv).

- ² Depending on the DrvPOL pad status, HDrv can be active by HIGH state (default) or by a LOW state.
- ³ OCPMode=0, AsyncEnbl=0

Input DrvPOL changes the polarity of HDrv and LDrv. DrvPOL HIGH means that HDrv and LDrv are active when in HIGH state. Conversely, DrvPOL LOW makes HDrv and LDrv to be active when LOW. This feature allows parts of the XTR30010 family to be used with non-inverting or inverting drivers as well as N-type or P-type transistors. This feature is only available at die level or in a custom packaging configuration.



Internal Blocks and Functional Features

Supply voltage generation

The power supply block is composed by a voltage reference, a linear voltage regulator and a supply monitoring block.

An auxiliary input VOUT is used in case where the user de-sires to feed back the DC-DC output voltage to supply the controller. In such a case the DC-DC output voltage must be set to 5V ($\pm 10\%$)⁴ only. This operating mode must be enabled by setting /LPMode=0.

The low-power mode can also be used without feeding back a voltage on VOUT. Indeed, in this case when /PGood is asserted, the internal regulator supplies all blocks (including external power drivers if desired) with a lower voltage (4V).

Voltage reference

The voltage reference is of type band-gap and has a fixed output of 1.2V. This reference is used within the internal linear regulator as well as in the control loop as input of the error amplifier.

Linear voltage regulator

The linear voltage regulator supplies the internal circuitry as well as any external block connected to node VDD. The nominal output voltage is 5V, but it provides 4V when in low-power mode (/LPMode=0) after PGood flag is asserted. The internal regulator is able to source up to 25mA for both output voltages. When ENABLE is pulled LOW, the internal LDO shuts down its output to GND.

The linear regulator output VDD must be externally connected to PVDD (eventually through some low-pass filtering) in order to supply the controller output buffers of HDrv & LDrv. A total load capacitance (on VDD & PVDD) between 300nF and 10uF is recommended for stability reasons. For proper operation, an input capacitor on VIN is also required (100nF or more).

Enable

When the ENABLE input goes under V_{ENOFF} threshold, XTR30010 parts enter into shutdown mode, with the internal linear regulator and drivers outputs turned off. Output VDD is internally pulled down with a strength of about 1mA to prevent any unwanted behavior. The VDD terminal of the XTR30010 cannot be forced to any voltage while ENABLE is LOW, otherwise malfunction or damage may occur. In case one of the outputs of the DC-DC converter (5V only) is connected to the VOUT terminal, this output voltage will discharge with a current of 1 mA. Additionally, PGood terminal is pulled down. When ENABLE is pulled above V_{ENON} , the PWM controller initiates a soft-start cycle.

ENABLE must not be connected to VDD (or PVDD) as this would prevent the internal regulator to start up. If not used, connect ENABLE to VIN.

- ⁴ **WARNING:** if the voltage applied on VOUT is higher than 5.5V, the part may be permanently damaged. See **"Recommended Operating Conditions"** section.

Under-voltage lockout (UVLO)

The UVLO block monitors the supply voltage on VDD, ensuring that the internal oscillator and output drivers remain in the off state and by resetting the internal voltage of the SS/TR input to GND whenever VDD is below an internally set threshold. Notice that SS/TR can still be forced to a positive voltage, in case a voltage source is connected to implement the tracking functionality. Normal operation is achieved whenever VDD voltage goes above 4V. The UVLO block activates again whenever VDD drops below 3.5V. When VDD goes above 4V, the XTR30010 initiates a soft-start sequence.

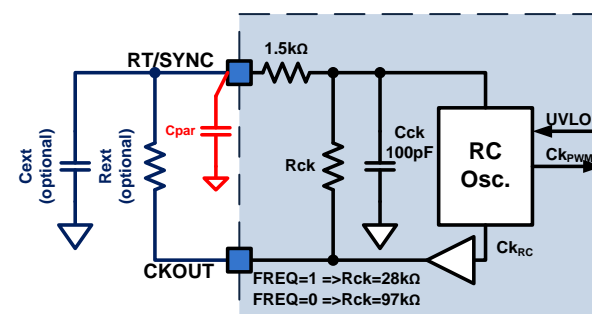
Oscillator

The internal oscillator generates a square clock signal (duty-cycle=50%) CkRC based on internal R_{ck} and C_{ck} . External resistor (decrease) and capacitor (increase) can be used in parallel with the internal ones through node RT/SYNC and CKOUT in order to change the oscillating frequency.

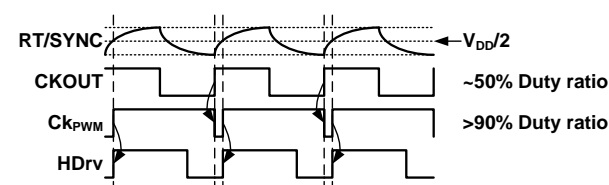
The oscillation frequency is given by the following relation (not taken into account the 1.5k Ω ESD resistor):

$$Freq = \frac{1}{T_{CK}} = \frac{1}{0.45 \cdot R_{Eff} \cdot C_{Eff} + 350ns}$$

$$R_{Eff} = R_{Ext} // R_{ck} \text{ and } C_{Eff} = C_{Ext} + C_{par} + C_{ck}.$$



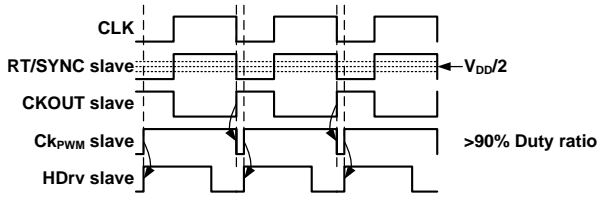
The following figure shows the evolution of signals on RT/SYNC, CKOUT, the internal PWM clock CkPWM and HDrv.



The signal on RT/SYNC is the charge and discharge of series resistor and capacitor between two thresholds equally spaced from $V_{DD}/2$. This leads to a CKOUT signal with a duty ratio close to 50%. When CKOUT goes up, an internal monostable is triggered ensuring a minimum off-time of the signal on HDrv. This minimum off-time of about 100ns sets the limit of the maximum possible output duty ratio. The internal PWM (HDrv) signal is triggered ON at the rising edge of the internal CkPWM signal.

Synchronization of a PWM controller to an external clock, provided by another PWM controller or independent clock, is possible by directly driving the RT/SYNC terminal of the slave controller by the desired clock signal. The source providing the synchronizing clock must have an output impedance smaller than 6k Ω .

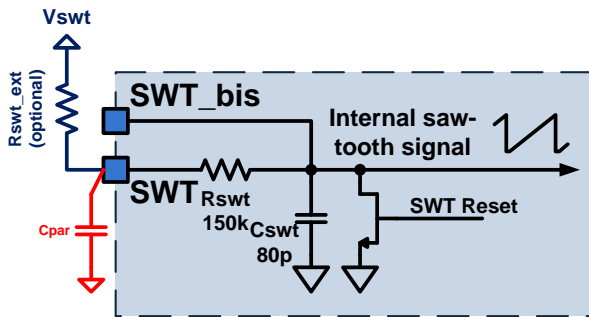
The following figure shows a CLK signal fed to the RT/SYNC terminal of a slave controller. Notice that there is a phase inversion between the voltage on RT/SYNC and CKOUT of the slave device.



Saw-tooth signal generation

The saw-tooth signal is generated by the charge of an internal capacitor C_{SWT} (80pF) through an internal resistor R_{SWT} (150k Ω). Packaging versions XTR30011 and XTR30014 allow the addition of an optional external resistor in series with the internal R_{SWT} (150k Ω), placed between node SWT and a positive supply voltage. The parasitic capacitance on pin SWT must be minimized (10pF or lower if possible). In Buck-like converters, using V_{IN} as positive supply for the external saw-tooth resistor allows implementing the voltage feed-forward in order to have a loop gain independent of the supply voltage. In packaging options where SWT is not available (XTR30015, XTR30016), SWT is internally connected to V_{IN} , which fixes the range of reachable duty-cycles depending on the value of V_{IN} . The corresponding RC time constant should preferably be much larger than the maximum expected ON time of the PWM in order to have a quasi linear saw-tooth (i.e. approximately constant PWM loop gain).

In a more general case, an external resistor R_{SWT_Ext} can be added to the internal R_{SWT} and a voltage different from V_{IN} can be used for saw-tooth signal generation. In such a case the total effective resistance $R_{SWT_Tot} = R_{SWT} + R_{SWT_Ext}$ must be considered.



The slope of the internal saw-tooth signal used for PWM generation is given by

$$Slope_{SWT} = \frac{V_{SWT}}{R_{SWT_Tot} \cdot C_{SWT}}$$

The minimum allowed V_{SWT} voltage is 4V.

If V_{IN} and only the internal R-C components are used for saw-tooth generation, the slope value is

$$Slope_{SWT} = \frac{V_{IN}}{R_{SWT} \cdot C_{SWT}} = \frac{V_{IN}}{150k\Omega \cdot 80pF} = \frac{V_{IN}}{12\mu sec}$$

For loop gain determination, what matters is the "theoretical" peak saw-tooth voltage obtained from the following equation

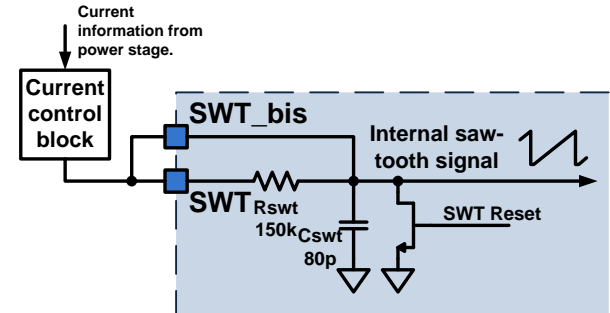
$$V_{Peak} = \frac{V_{SWT}}{R_{SWT_Tot} \cdot C_{SWT} \cdot Freq} = \frac{V_{SWT}}{R_{SWT_Tot} \cdot C_{SWT}} \cdot T_{CK}$$

$Freq = 1/T_{CK}$ is the oscillation frequency of the PWM clock.

Note that V_{Peak} is the theoretical value that the internal saw-tooth signal would reach at the end of the clock period. Even if the theoretical V_{Peak} can be of several volts, what is really relevant is that the intersection between the saw-tooth signal and COMP happens under 2V. Otherwise said, the value of COMP in steady state should be 2V maximum. The intersection between the saw-tooth signal and

COMP determines the maximum duty cycle that the PWM controller can reach in the target application.

In part numbers XTR30017, XTR30018 and at die level, terminal SWT_bis is available (already connected to SWT for XTR30017 and XTR30018). This node allows bypassing the internal saw-tooth generation resistor R_{SWT} , directly accessing to the internal capacitor terminal. The SWT_bis terminal can be used to implement current-mode control by adding some external components. To ensure a correct reset of the saw-tooth signal, the injected current through SWT_bis should not be higher than 200 μ A.



Soft-start and tracking functionality

The soft-start feature of the XTR30010 controls the output voltage rise speed, limiting the inrush current during start-up. External resistor and capacitor can be added from the SS/TR node to GND in order to increase the soft-start period. The soft-start period is determined by the equation ($Freq$ is the clock frequency):

$$t_{ss} = \frac{1.2V \cdot 2^{14}}{Freq \cdot V_{DD}} \cdot \frac{R_{SSExt} + 127k}{R_{SSExt}} \text{ with } R_{SSExt} > 40k\Omega$$

If no external resistor is used:

$$t_{ss} = \frac{1.2V \cdot 2^{14}}{Freq \cdot V_{DD}}$$

When the SS/TR input is driven by an external source below V_{ref} , the output voltage tracks the voltage applied on SS/TR. Notice that there is a systematic offset between SS/TR and FB during operation (see Electrical Specifications section). For any mode other than the Interleaves mode of operation, output LDrv/ADrv is inactive whenever the voltage on SS/TR is below 90% of V_{ref} .

Power-good flag

PGood is an active-HIGH output flag indicating that the DC-DC output is within a given range of values and that no overcurrent event is present.

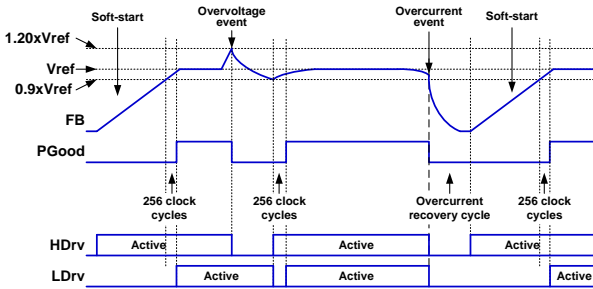
Output voltage sensing is performed on node FB. Whenever FB goes outside the range 90-120% of V_{ref} (1.2V), PGood is immediately pulled down. In case of an overvoltage on FB (>120% V_{ref}), the high-side output driver (HDrv) is turned off until FB reaches 90% of V_{ref} , in which case the controller enters again into normal operation. Once that FB goes back above 90% of V_{ref} , the PGood flag remains low for a period of about 256 clock cycles. When the HDrv driver is active again the output of the error amplifier COMP may be at an elevated value, depending on the loop filter speed. If COMP remains below $DCLimit$, the value of COMP will determine the output duty-cycle. If COMP is slightly above $DCLimit$, the output duty-cycle is determined by $DCLimit$. If COMP goes above $DCLimit + 1.5V$, the controller understands this situation as a critical error and self resets, giving rise to a full soft-start cycle. If $DCLimit$ is externally forced above 2V, when the HDrv starts operating again, as COMP could be quite high, the output duty-cycle could be close to 100%. Depending on components used for the output LC filter and loop filter, this operation at high duty-cycle may give rise to an output overshoot, setting FB again above 120% and starting over a new recovery cycle.

For this reason, it is strongly recommended to limit the duty-cycle by setting DCLimit to an adequate value.

In an overcurrent (or short-circuit) event, PGood is immediately set LOW and an overcurrent recovery cycle starts followed by a soft-start cycle.

PGood is also pulled down in case of UVLO conditions and whenever ENABLE is LOW.

PGood output is softly pulled up to VDD through an internal 600kΩ resistor. Pull-up strength can be reinforced by connecting an external resistor between PGood and VDD. It is not allowed to pull PGood higher than VDD.



Error amplifier

The XTR30010 error amplifier is of Miller-type OTA. The amplifier is capable of using Type II or Type III compensation filters, though in all cases the filter feedback must not have any DC path (capacitive feedback only) in order to keep a large DC gain.

In open loop, the error amplifier presents a GBW above 1.1MHz and a phase margin better than 40° for load capacitances up to 90pF. At PCB level, the FB and COMP nodes should be protected from any noisy signal.

PWM signal generation

XTR30010 parts can operate in standard or pulse-skipping PWM generation modes.

In standard PWM mode, the internal saw-tooth signal is compared against the minimum of COMP (output of the error amplifier) or DCLimit (duty-cycle limitation).

The DCLimit analog input allows clamping of the maximum PWM duty-cycle (volt-second clamping). When the saw-tooth reaches Min[COMP, DCLimit], a reset is asserted to the PWM logic, which in turn resets HDrv to the off state.

In a buck architecture, this duty-cycle limitation allows limiting the inductor current increase during the high side turn-on period (where the short-circuit protection is not active) in case of short-circuit. As soon, as the ON period finishes, the short-circuit protection senses the inductor current and immediately turns the PWM off if required.

In a flyback, forward or push-pull architecture, the volt-second clamping functionality provided by DCLimit can be used to prevent transformer saturation.

The DCLimit voltage is set by default to 40% of the VDD voltage (i.e. 2V for VDD=5V) with an internal 120kΩ resistor. The DCLimit threshold can be lowered if needed using an external resistor to ground (RDCLimit) or an external voltage source. It is not recommended to set DCLimit above 2V. However, if the DCLimit functionality is not desired, DCLimit can be directly connected to VDD, but in this case there is no volt-second clamping.

The volt-second clamping is given by

$$V_{SWT} \cdot t_{ON} = V_{DCLimit} \cdot R_{SWT_Tot} \cdot C_{SWT}$$

The default volt-second clamping value is 24V·μsec (VDCLimit=2V, RSWT=150kΩ, CSWT=80pF).

From the equation above, the maximum ON time that can be achieved with the internal RSWT and CSWT for given VIN and VDCLimit is

$$t_{ON_Max} = \frac{V_{DCLimit}}{Slope_{SWT}} = \frac{V_{DCLimit} \cdot R_{SWT_Tot} \cdot C_{SWT}}{V_{IN}}$$

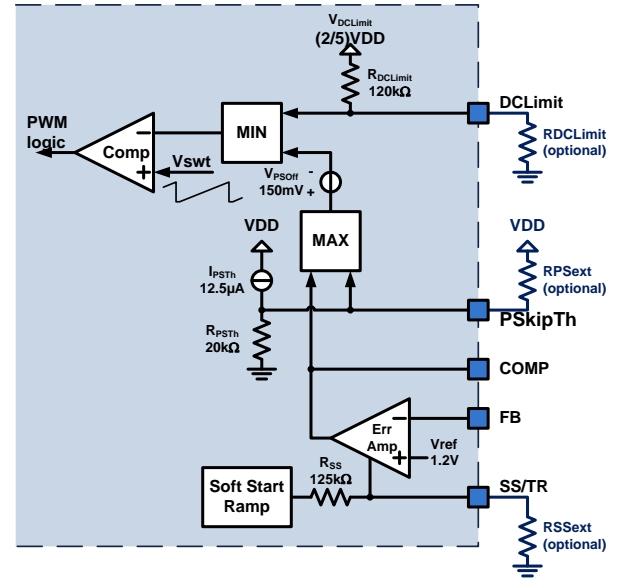
Knowing tON_Max, the maximum achievable duty-cycle is

$$D_{Max} = t_{ON_Max} \cdot Freq = \frac{t_{ON_Max}}{T_{CK}}$$

Notice that for the XTR30015 and XTR30016 RSWT, CSWT and VDCLimit are internally set and cannot be externally changed. This gives a maximum ON time determined by VIN as follows

$$t_{ON_Max} = \frac{2V \cdot 150k\Omega \cdot 80pF}{V_{IN}} = \frac{24V \cdot \mu sec}{V_{IN}}$$

If COMP goes above DCLimit + 1.5V, the PWM controller interprets this as an “unusual” event (rapid overload or loss of control loop) and it enters into a short-circuit recovery cycle. See section “Over-current protection” below.



For improved efficiency at low load currents, pulse-skipping mode can be used by ensuring PSkipEnb=1. When pulse-skipping is enabled, the equivalent circuit of the PWM generator can be depicted as in the figure below.

During start-up, pulse-skipping mode is forced to ensure that settling to the final output voltage is achieved smoothly even for operation under very low duty ratios. An analog input PSkipTh is used to set minimum allowed on-time which must be adapted for given Vin-Vout-Freq parameters. For Buck converters (OCPMode=1), pulse-skipping mode takes place when operating in asynchronous mode only. In pulse-skipping mode, the output of the error amplifier is also compared against the saw-tooth signal, but in this case if COMP is under a given threshold, the controller keeps a minimum tON given by:

$$t_{ON} = \frac{V_{PSTH} - V_{PSOFF}}{S_{SWT}}$$

$$V_{PSTH} = \left(\frac{V_{DD}}{R_{PSEXT}} + I_{PSTH} \right) \cdot (R_{PSEXT} // 20k)$$

$$V_{PSOFF} = 150mV, S_{SWT} = V_{IN} / (R_{SWTE} \cdot C_{SWT}), I_{PSTH} = 12\mu A$$

In the previous equation it is supposed that an external RPSExt is used between VDD and PSkipTh. If no RPSExt is used, VPSTh=250mV. When COMP is below PSkipTh, a dedicated block masks the clock setting pulses. The system enters into fixed tON mode which leads to a variable effective output frequency, but still synchronized by the internal clock which runs at a fixed frequency.

In a general case for a Buck converter where a voltage VSWT is used to generate the saw-tooth signal, the output current at which pulse-skipping starts can be approximately determined by

$$I_{OutPS} = \frac{Freq \cdot [R_{SWT_Tot} \cdot C_{SWT} \cdot (V_{PSTh} - V_{PSoff})]^2}{2 \cdot L} \cdot \frac{V_{IN} - V_{OUT}}{V_{SWT}^2 \cdot V_{OUT}} \cdot V_{IN}$$

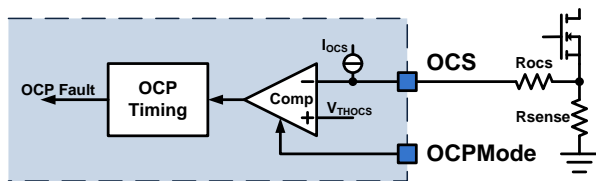
In case input voltage feed forward is used ($V_{SWT}=V_{IN}$) the equation for I_{OutPS} becomes

$$I_{OutPS} = \frac{Freq \cdot [R_{SWT_Tot} \cdot C_{SWT} \cdot (V_{PSTh} - V_{PSoff})]^2}{2 \cdot L} \cdot \frac{V_{IN} - V_{OUT}}{V_{IN} \cdot V_{OUT}}$$

If $R_{SWT_Tot}=150k\Omega$, $C_{SWT}=80pF$, $L=10\mu H$, $V_{IN}=30V$, $V_{OUT}=5V$ and $V_{PSTh}=0.5V$, $Freq=520kHz$, then $I_{OutPS}=76mA$.

Over-current protection

Over-current protection is achieved by sensing the voltage on a resistor in series with the source of the low-side transistor or directly on the switching node SW (assuming that the R_{ON} of the synchronous rectifier transistor is known).



Control input OCPMode sets the sensing polarity on OCS node. For a Buck converter, the voltage sensed is negative (OCPMode=1). For boost, buck-boost, flyback or push-pull converters, the voltage sensed is positive (OCPMode=0).

An external resistor together with an internal current source I_{OCS} are used to set the over-current detection threshold. When an overcurrent state is detected, a recovery cycle starts immediately turning off the output drivers for a period of about 16100 clock cycles. After this period a new soft-start sequence is reinitiated. In this mode, hiccup current limiting is achieved.

The overcurrent threshold is determined by:

$$I_{OCP} = \frac{R_{OCS}}{R_{sense}} \cdot I_{OCS} \quad \text{for OCPMode=1}$$

$$I_{OCP} = \frac{V_{THOCS} - I_{OCS} \cdot R_{OCS}}{R_{sense}} \quad \text{for OCPMode=0}$$

For the second case (OCPMode=0), R_{OCS} should preferably be smaller than 3-4k Ω , as larger values would give a poor precision on the short circuit protection threshold. Due to the fast transient response of the node used for current sensing, any parasitic capacitance on node OCS makes a low-pass filter with R_{OCS} resistor. To compensate for this effect, an external capacitor can be placed in parallel with R_{OCS} . This capacitor should be at least one order of magnitude larger than the expected parasitic capacitance on the OCS pin.

As mentioned in the previous PWM section, the short-circuit protection through the OCS sensing operates just after PWM signal goes low if OCPMode=1 and just before the end of the ON time of the PWM if OCPMode=0.

With OCPMode=1, terminal SW is used as a trigger to enable the OCS detection. This means that SW shall go below 0V to enable OCS detection on the current conduction cycle. This triggering mechanism is not present, nor needed, when OCPMode=0.

If the current increase through the inductor during the ON time of the PWM can be larger than the expected short-circuit current protection threshold, it is highly recommended to limit the maximum duty cycle using the DCLimit analog input pin.

Indeed, a second short circuit protection is also integrated by means of the DCLimit pin. This protection triggers a short-circuit recovery cycle whenever the error amplifier goes outside its linear regime (COMP above DCLimit + 1.5V). For a strong short-circuit event (i.e. very low load impedances), COMP can rise quickly towards VDD (speed depends on the external RC filter of the error amplifier). In such a case, the XTR30010 will consider a short-circuit event happened, even if the current sense is still in the blind period. On the other side, in case of

an overcurrent (i.e. not strong short circuit), the COMP output rising can be much slower, so that the overcurrent event could be detected quite late. In such case, the over current will be first detected by the short circuit protection through the OCS terminal.

It is important to notice that second short circuit protection based on DCLimit is always active, even if the OCS pin is not used. Nevertheless, it is possible to inhibit this second protection by connecting DCLimit to VDD in the packages that have available DCLimit. In such a case it is no longer possible to limit the maximum duty cycle of the PWM controller.

Output drivers & drivers control

The output drivers are able to source and sink at least 50mA at 230°C. By default, the HDrv and LDrv outputs are considered ON when they are at HIGH level. However, at die level, there is a pad DrvPOL which, when grounded, allows to reverse the logic (ON at LOW level). Both the LDrv and HDrv outputs are referenced to PGND and are able to provide a signal up to 5V (PVDD) of amplitude.

The drivers control block has anti-shoot through capabilities. Prevention of cross conduction is achieved by feeding back HDrv and LDrv nodes to the drivers control block for whatever the DrvPOL state. However, it is important that the used external drivers (high side and low side) present a delay mismatch smaller than the non-overlap period of the XTR30010 controller defined earlier in the electrical specification.

System start-up is carried out in pulse-skipping mode forced internally until FB goes above 90% of the internal 1.2V reference.

In case an overcurrent event is detected, both the HDrv and LDrv outputs are set OFF for an internally timed recovery period. After this recovery period, a soft-start cycle is initiated.

When an overvoltage event is detected (FB going above 120% of 1.2V), the HDrv is set off, while LDrv remains active, until FB recovers to 90% of Vref (1.2V).

For Buck converters only (OCPMode=1), a special feature, called “**Forced bootstrap capacitor pre-charge**” has been introduced in order to force the switching node SW to ground at some moments thus making sure the bootstrap capacitor charges. This is critical for the external high-side driver in order to guarantee a minimum charging of the associated bootstrap capacitor when the driver has no integrated charge pump circuitry. In normal operation (except pulse skipping), the SW node of a Buck converter is supposed to go to a slightly negative voltage at each clock period. At that moment, the bootstrap capacitor can be pre-charged. The high side driver will then operate as expected. If for any reason, the bootstrap capacitor is not pre-charged enough, the high side switching device cannot be turned on correctly anymore. The result is that the SW node will not be pulled down any more below ground by the output inductor. This can be an incorrect stable state from which the DC-DC cannot recover from itself. In order to avoid such condition, the XTR30010 controller (when OCPMode=1) continuously checks if the SW node goes below about +1V at each clock period. If during 16 consecutive clock periods, the SW node never goes below this threshold, the PWM logic will force the LDrv output ON the next clock period as soon as the HDrv output is OFF. In practice, the duration of the LDrv pulse is very short (100ns range). As soon as SW goes below +1V, the LDrv turns OFF. Even during this short pulse, the system guarantees that HDrv and LDrv are never ON together.

In normal operation, the short LDrv pulse that occurs whenever SW remains positive over 16 clock periods can be observed at very low load current condition, when the system goes in deep pulse skipping (i.e. the PWM remains OFF for more than 16 clock periods) due to low load currents. The effect of this brief pulse on the output voltage ripple is nearly not visible. Without this short pulse, the bootstrap capacitor could discharge during asynchronous or pulse skipping operation and block the system. In case this “Forced bootstrap capacitor pre-charge” feature is not desired, it is possible to deactivate it by setting AsyncEnbl=0 and PSkipEnbl=1. This feature is not available for non Buck converters (OCPMode=0).

System design guidelines

- FB, COMP and OCS terminals are sensitive to system noise. Layout these terminals with minimum parasitic capacitance and avoid any possible coupling with SW, HDrv, LDrv, CKOUT and PGOOD signals.
- Noise on RT/SYNC could cause erratic behavior of the internal clock generator. Avoid any possible coupling with SW, HDrv, LDrv, CKOUT and PGOOD signals. In case a capacitor is connected to RT/SYNC to slow down the clock, connect the capacitor to a noiseless GND. Do not connect this capacitor to PGND under any condition.
- Notice that terminal OCS is relative to PGND (not GND).
- Connect a capacitor of at least 1nF on terminals determining operational thresholds (PSkipTh and DCLimit) to avoid any possible noise. For PSkipTh connect this capacitor to GND and for DCLimit connect the capacitor to VDD.
- When using “input voltage feedforward”, connect SWT to VIN through a resistor of at least 100Ω.

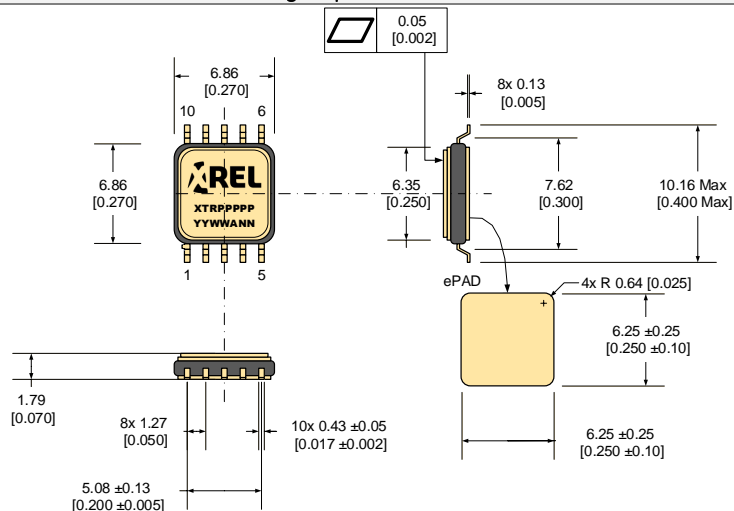
Summary of Operating Modes

Desired Functionality	OCPMode	PSkipEnbl	AsyncEnbl	IntlvMode
Buck mode with asynchronous and pulse skipping enabled. “Forced bootstrap capacitor pre-charge” active.	1	1	1	0
Buck mode with asynchronous and pulse skipping enabled. “Forced bootstrap capacitor pre-charge” inactive.	1	1	0	0
Buck mode with asynchronous enabled and pulse skipping disabled. “Forced bootstrap capacitor pre-charge” active.	1	0	1	0
Buck mode with fixed synchronous mode (after startup). “Forced bootstrap capacitor pre-charge” active.	1	0	0	0
Boost, buck-boost, flyback modes (complementary non-overlapped outputs). Pulse skipping mode enabled.	0	1	1	0
Boost, buck-boost, flyback modes with LDrv permanently off. Pulse skipping mode enabled.	0	1	0	0
Boost, buck-boost, flyback modes (complementary non-overlapped outputs). Pulse skipping mode disabled.	0	0	1	0
Boost, buck-boost, flyback modes with LDrv permanently off. Pulse skipping mode disabled.	0	0	0	0
Interleaved mode only. Pulse skipping mode enabled.	0	1	X	1
Interleaved mode only. Pulse skipping mode disabled.	0	0	X	1

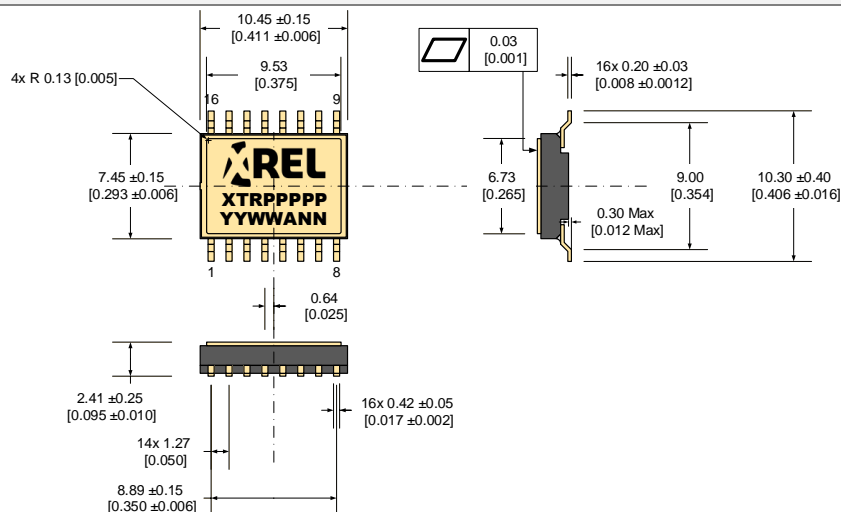
PACKAGE OUTLINES

Dimensions shown in mm [inches]. Tolerances ± 0.13 mm [± 0.005 in] unless otherwise stated.

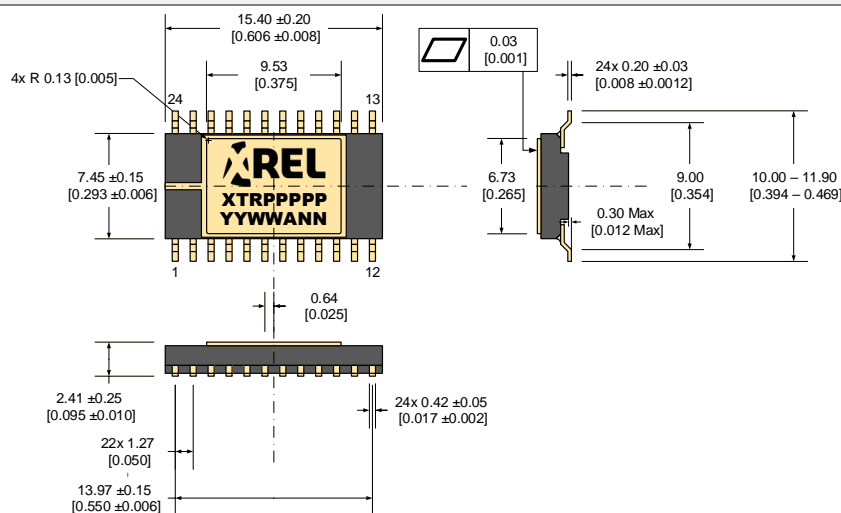
Gull-wing flat pack with ePad CDFP10



Ceramic Small Outline IC SOIC16



Ceramic Small Outline IC SOIC24



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